HD63450, HD63450Y, HD63450P HD63450PS, HD63450CP CMOS Direct Memory Access Controller

SEPTEMBER, 1989

🕲 HITACHI

The HD63450 is a CMOS Direct Memory Access Controller (DMAC). It is upwardly compatible with the NMOS DMAC HD68450.

In addition to the NMOS DMAC HD68450 features, the HD63450 performs one or several blocks of data transfer (Operand; byte, word, or long word) between memory and peripheral device at high speed. The block transfer restart operation is provided (Multi-Block Transfer with $\overline{\rm DONE}$ Mode). The number of operands in a block is determined by a transfer count.

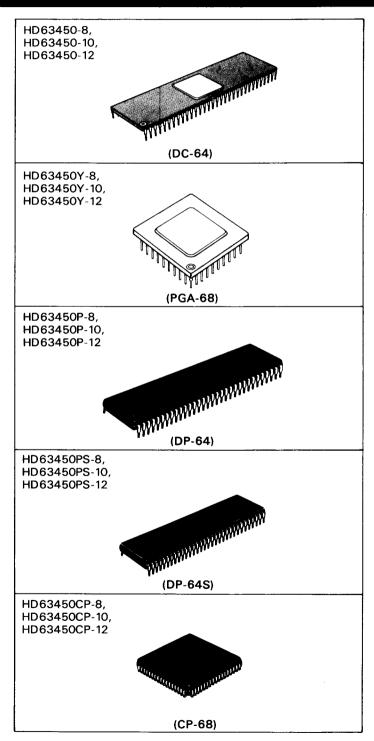
Fabricated in CMOS for lower power dissipation.

■ FEATURES

- HD 68000 Bus Compatible
- •4 independent DMA Channels with Programmable Priority
- Memory-to-Memory, Memory-to-Device, Device-to-Memory
 Transfers
- Programmable 8-Bit or 16-Bit I/O Device Types
- Auto-Request and External-Request Transfer Modes
- Interface Lines for Requesting, Acknowledging, and Incidental Control of the Peripheral Devices
- Block Transfer Operation

In Single-Block : In Multi-Block :

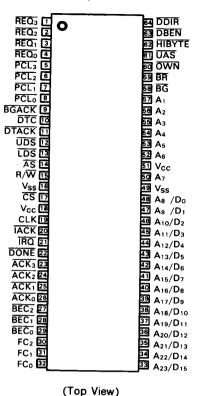
- Unchaining Transfer
- Continue Mode Transfer
- Array-Chaining and Linked-Array-
- Chaining Transfers
- Multi-Block Transfer with DONE
- ●68000 Bus Exception Processing Support
- ●2 Vectored Interrupts for each Channel
- Variable System Bus Bandwidth Rate Utilization
- Fast Transfer Rates: Up to 6.25 Mbytes/sec. at 12.5 MHz
- CMOS +5 Volts Operation



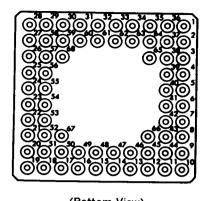
TYPE OF PRODUCTS

Type No.	Bus Timing	Packaging		
	 	, ackaging		
HD63450-8	8MHz			
HD63450-10	10MHz	DC-64		
HD63450-12	12.5MHz			
HD63450Y-8	8MHz			
HD63450Y-10	10MHz	PGA-68		
HD63450Y-12	12.5MHz			
HD63450P-8	8MHz			
HD63450Y-10	10MHz	DP-64		
HD63450Y-12	12.5MHz			
HD63450PS-8	8MHz			
HD63450PS-10	10MHz	DP-64S		
HD63450PS-12	12.5MHz]		
HD63450CP-8	8MHz			
HD63450CP-10	10MHz	CP-68		
HD63450CP-12	12.5MHz			

■ PIN ARRANGEMENT • HD63450, HD63450PS



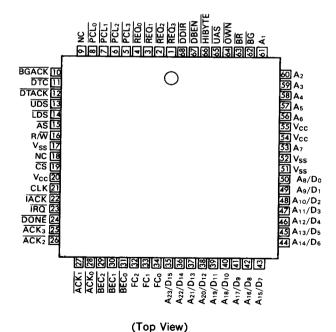
● HD63450Y



(Bottom View)

Pin No.	Function	Pin No.	Function	Pin No.	Function	Pin No.	Function
1	N/C	18	PCL ₁	35	A19/D11	52	BGACK
2	A13/D5	19	DTACK	36	A17/D9	53	LDS
3	A11/D3	20	UDS	37	A15/D7	54	Vss
4	A10/D2	21	ĀS'	38	A12/D4	55	Vcc
5	Aa/Do	22	R/W	39	A ₉ /D ₁	56	DONÉ
6	A7	23	N/C	40	Vss	57	IRQ
7	A ₆ .	24	CS	41	Vcc	58	ACK ₂
8	A 5	25	CLK	42	A4	59	BEC ₂
9	A ₃	26	IACK	43	A ₂	60	BEC ₀
10	N/C	27	ACK₃	44	BG	61	FC ₀
11	BR	28	ACK ₀	45	OWN	62	A21/D13
12	UAS	29	BEC ₁	46	HIBYTE	63	A18/D10
13	DBEN	30	FC ₂	47	DDIR	64	A ₁₆ /D ₈
14	REQ₃	31	FC ₁	48	REQ.	65	A14/D6
15	ŘEQ₂	32	A23/D15	49	PCL ₂	66	A ₁
16	REQ ₀	33	A22/D14	50	PCLo	67	DTC
17	PCL ₃	34	A ₂₀ /D ₁₂	51	N/C	68	ACK ₁

● HD63450CP



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	
Supply Voltage	V _{CC} *		Unit
Input Voltage		-0.3~+7.0	V
	V _{in} *	-0.3~Vcc+0.3	V
Operating Temperature Range	Topr	0~+70	<u>·</u>
Storage Temperature	T-1-		
ACL	l stg	−55 ∼ +150	°C

^{*}With respect to VSS (SYSTEM GND)

(NOTE) Permanent damage to the device may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of the device.

RECOMMENDED OPERATING CONDITIONS

item	Symbol	min	da em		
Supply Voltage			typ	max	Unit
oupply voltage	Vcc*	4.75	5.0	5.25	٧
Input Voltage	V _{IH} *	2.0		Vcc	
	V _{IL} *	-0.3		0.8	V
Operating Temperature	Topr	0	25	70	<u>·</u>
With respect to Vss (SYSTEM CND)	—— ———————————————————————————————————			/0	C

■ ELECTRICAL CHARACTERISTICS

\bullet DC CHARACTERISTICS (V_{CC}=5V \pm 5%, V_{SS}=0V, T_a=0 \sim +70°C, unless otherwise noted.)

	Item	Symbol	Test Condition	min	typ	max	Unit
Input "High" Voltage		ViH		2.0	-31	Vcc	V
Input "Low" Voltage		VIL		Vss-0.3		0.8	V
Input Leakage Current	CS, IACK, BG, CLK, BEC ₀ ~BEC ₂ REQ ₀ ~REQ ₃	lin		733 0.0		10	μΑ
Three-State (Off State) Input Current	A ₁ ~A ₇ , D ₀ ~D ₁₅ /A ₈ ~A ₂₃ , AS, UDS, LDS, R/W, UAS, DTACK, BGACK, OWN, DTC, HIBYTE, DDIR, DBEN, FC ₀ ~FC ₂ , PCL ₀ ~PCL ₃	ITSI				10	μА
Open Drain (Off State) Input Current	IRQ, DONE	Горі				20	μA
Output "High" Voltage	A1~A7, D0~D15/A8~A23, AS, UDS, LDS, R/W, UAS, DTACK, BGACK, BR, OWN, DTC, HIBYTE, DDIR, DBEN, ACK0~ACK3, PCL0~PCL3, FC0~FC2	Vон	Іон = — 400 µ A	Vcc-2.0			V
	A ₁ ~A ₇ , FC ₀ ~FC ₂	Vol	loL = 3.2mA			0.5	
Output "Low" Voltage	D ₀ ~D ₁₅ /A ₈ ~A ₂₃ , AS, UDS, LDS, R/W, DTACK, BR, OWN, DTC, HIBYTE, DDIR, DBEN, ACK ₀ ~ACK ₃ , UAS, PCL ₀ ~PCL ₃ , BGACK	Vot	loL=5.3mA			0.5	v
	IRQ, DONE	VoL	loL=8.9mA			0.5	
Power Dissipation		PD	f=8MHz, V _{CC} =5.0V T _a =25°C		0.5	1.0	w
Capacitance		Cin	V _{in} =0V T _a =25°C, f=1MHz			15	рF



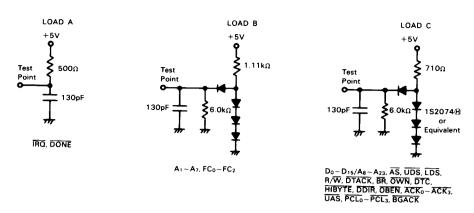


Figure 1 Test Loads

ullet AC ELECTRICAL SPECIFICATIONS (Vcc=5V±5%, Vss=0V, Ta=0 \sim +70°C, unless otherwise noted.)

Frequency of Operation 1					81	ИНz	10	MHz	12.	5MHz	T
Frequency of Operation	No.	Item	Symbol	Test Condition	Ve ₁	rsion	Ve	rsion	Ve	rsion	Unit
Clock Period					min	max	min	max	min	max	
Clock Width Low			f		4.0	8.0	4.0	10.0	4.0	12.5	MHz
Clock Width High			tcyc		125	250	100	250	80	250	ns
Clock Fill Time			tcL]	55	125	45	125	35	125	ns
10		<u> </u>	tсн		55	125	45	125	35	125	ns
10			tcf			10		10		5	ns
To Data in to DBEN Low Store Low			tcr			10		10		5	ns
8 DTACK Low to Data Invalid toTILDI 9 Address in to ĀS in Low to AS, DS in High to Address in Invalid tsinary 10 ĀS, DS in High to Address in Invalid tsinary 11 Clock High to DDIR Low tchort 12 Clock High to DDIR High telephance toShDRZ 13 DS in High to DDIR High Impedance toShDRZ 14 Clock Low to DBEN High telephance toShDRZ 15 Clock Low to DBEN High telephance toShDRZ 16 DS in High to Data Out Valid (MPU read) tchown 18 DS in High to Data Out Valid (MPU read) tchown 19 DS in High to Data Out Invalid toShDZ 19 DS in High to DTACK Low to DTACK Low to Clock Low to DTACK Low to Clock Low to DTACK High telephance toShDZ 20 Clock Low to DTACK High telephance toShDZ 21 DS in High to DTACK High telephance toShDZ 22 DTACK Width High toTACK High telephance toShDZ 23 DS in High to DTACK High Impedance toShDZ 24 DTACK Low to DS in High toTACK High telephance toShDZ 25 REQ Width Low telephance toShDZ 26 REQ Low to BR Low telephance toShDZ 27 Clock High to BR Low telephance toShDZ 28 Clock High to BR Low to Loher telephance toShDZ 29 BG Low to BRACK Low telephance toShDZ 20 Clock High to BR Low toBRC Low telephance toShDZ 21 DS In High to DTACK High Impedance toShDZ 22 DTACK Width High telephance toShDZ 23 DS In High to DTACK High Impedance toShDZ 24 DTACK Low to BR Low telephance toShDZ 25 REQ Width Low telephance toShDZ 26 REQ Low to BR Low telephance toShDZ 27 Clock High to BR Low telephance toShDZ 28 Clock High to BR Low telephance toShDZ 30 BR Low to MPU Cycle End (AS in High) telephance t			tası		20		15		15		ns
9 Address in to AS in Low 10 AS, DS in High to Address in Invalid 110 AS, DS in High to Address in Invalid 120 Clock High to DDIR Low 131 DS in High to DDIR High 141 Clock Low to DBEN Low 152 Clock Low to DBEN Low 153 DS in High to DDIR High Impedance 154 Clock Low to DBEN High 155 Clock Low to DBEN High 156 DS in High to Data Out Valid (MPU read) 175 Clock High to Data High Impedance 186 DS in High to Data Out Valid (MPU read) 187 DS in High to Data High Impedance 198 DS in High to DATACK Low 199 DS in High to DATACK High 200 Clock Low to DTACK High 211 DS in High to DATACK High 221 DTACK Width High 231 DS in High to DTACK High Impedance 242 DTACK Low to DS in High 253 REQ Width Low 264 REQ Low to BR Low 275 Clock High to BR Low 176 Low 177 Low 170 60 55 ns 180 160 140 ns 180 160 140 ns 180 160 155 ns 180 160 155 ns 180 160 150 ns 180 160 160 ns 180 160 160 ns 180 0 0 0 0 ns 18			toidel		0		0		0		ns
10 AS, DS in High to Address in Invalid tsihatv			totloi		0		0		0	1	ns
10A DS in High to CS High 10SHCSH 11 Clock High to DDIR Low 1cHDRH 12 Clock High to DDIR High 1cHDRH 12 Clock High to DDIR High 1mpedance 1mshDRZ 12 Clock Low to DBEN Low 1cLDBL 120 110 110 ns 110 ns 110 110 ns 110 ns 110 110 ns 110 110 ns 110 110 ns 11			TAIASL]	0		0		0		ns
11 Clock High to DDIR Low Colkper 1.0 clkper 1.0 clk			tsihaiv		0		0		0		ns
12 Clock High to DDIR High 10 10 110			tознозн	1		1.0		1.0	clk.per.	1.0	clk.per.
13 DS in High to DDIR High Impedance toshdar		Clock High to DDIR Low	tCHDRL]		70		60		55	ns
14 Clock Low to DBEN Low 15 Clock Low to DBEN High 15 Clock Low to DBEN High 16 DS in High to DBEN High Impedance 15 Clock High to Data Out Valid (MPU read) 16 Clock High to Data Out Invalid 160 140 110			tchdrh]		70		60		55	ns
15 Clock Low to DBEN High 1clobh			toshorz	Figure1		120		110		110	ns
15 Clock Low to DBEN High 10 DS in High to DBEN High Impedance 10 110			tCLDBL			70		60		55	
16 DS in High to DBEN High Impedance toshdbz	15		tCLDBH	~		70		60		55	ns
17 Clock High to Data Out Valid (MPU read) 18 DS in High to Data Out Invalid 10 110	16		toshobz			120		110		110	
18 DS in High to Data Out Invalid toshozn 0 0 0 ns 19 DS in High to Data High Impedance toshoz 120 110 110 ns 20 Clock Low to DTACK Low tclotl 70 60 55 ns 21 DS in High to DTACK High toshoth 110 110 110 ns 22 DTACK Width High toth 10 10 10 ns 23 DS in High to DTACK High Impedance toshotz 180 160 160 ns 24 DTACK Low to DS in High tothoth 0 0 0 ns 25 REQ Width Low trequence 2.0 2.0 2.0 clk.per. 26 REQ Low to BR Low trelbru 250 200 160 ns 27 Clock High to BR High tchbr 70 60 55 ns 28 Clock High to BGACK Low tbsLbl 4.5 4.5 4.5 clk.per. <td>17</td> <td>Clock High to Data Out Valid (MPU read)</td> <td>tсном</td> <td>Figure8</td> <td></td> <td>180</td> <td></td> <td>160</td> <td></td> <td></td> <td></td>	17	Clock High to Data Out Valid (MPU read)	tсном	Figure8		180		160			
19 DS in High to Data High Impedance	_18		toshozn		0	_	0		0		
20 Clock Low to DTACK Low tclotl 70 60 55 ns	19	DS in High to Data High Impedance	toshoz			120		110		110	
21 DS in High to DTACK High toshdth 22 DTACK Width High 10 10 10 ns 23 DS in High to DTACK High Impedance toshdtz 180 160 160 ns 24 DTACK Low to DS in High totlosh 0 0 0 ns 25 REQ Width Low trequ 2.0 2.0 2.0 clk.per. 26 REQ Low to BR Low trelbru 250 200 160 ns 27 Clock High to BR Low tchbr 70 60 55 ns 28 Clock High to BR High tchbr 70 60 55 ns 29 BG Low to BGACK Low tbgLbL 4.5 4.5 4.5 clk.per. 30 BR Low to MPU Cycle End (AS in High) tbgLbL 4.5 4.5 clk.per.	20	Clock Low to DTACK Low	tCLDTL			70		60			
22 DTACK Width High tDTH 10 10 10 ns 23 DS in High to DTACK High Impedance tDSHDTZ 180 160 160 ns 24 DTACK Low to DS in High tDTLDSH 0 0 0 ns 25 REQ Width Low tREQL 2.0 2.0 2.0 clk.per. 26 REQ Low to BR Low tRELBRL 250 200 160 ns 27 Clock High to BR Low tCHBRL 70 60 55 ns 28 Clock High to BR High tCHBRH 70 60 55 ns 29 BG Low to BGACK Low tBGLBL 4.5 4.5 4.5 clk.per. 30 BR Low to MPU Cycle End (AS in High) total As in High) total As in High total As in High total As in High total As in High	21	DS in High to DTACK High	toshoth			110		110		110	
23 DS in High to DTACK High Impedance toshdtz 180 160 ns 24 DTACK Low to DS in High totldsh 0 0 0 ns 25 REQ Width Low tred 2.0 2.0 2.0 clk.per. 26 REQ Low to BR Low trelbr 250 200 160 ns 27 Clock High to BR Low tohbr 70 60 55 ns 28 Clock High to BR High tohbr 70 60 55 ns 29 BG Low to BGACK Low tbgLbL 4.5 4.5 4.5 clk.per. 30 BR Low to MPU Cycle End (AS in High) tbgLbL 4.5 4.5 clk.per.	22		tотн		10		10		10		
24 DTACK Low to DS in High totldsh 0 0 0 ns 25 REQ Width Low treqt 2.0 2.0 2.0 clk.per. 26 REQ Low to BR Low trelbrt 250 200 160 ns 27 Clock High to BR Low tchbrt 70 60 55 ns 28 Clock High to BR High tchbrh 70 60 55 ns 29 BG Low to BGACK Low tbglbt 4.5 4.5 4.5 clk.per. 30 BR Low to MPU Cycle End (AS in High) tbglbt tbglbt 0 </td <td>23</td> <td>DS in High to DTACK High Impedance</td> <td>toshotz</td> <td></td> <td></td> <td>180</td> <td></td> <td>160</td> <td></td> <td>160</td> <td></td>	23	DS in High to DTACK High Impedance	toshotz			180		160		160	
25 REQ Width Low trequ 2.0 2.0 clk.per. 26 REQ Low to BR Low trelbru 250 200 160 ns 27 Clock High to BR Low tchbru 70 60 55 ns 28 Clock High to BR High tchbru 70 60 55 ns 29 BG Low to BGACK Low tbglbl 4.5 4.5 4.5 clk.per. 30 BR Low to MPU Cycle End (AS in High) tbglbl 4.5 0 0 0 0 0	_24	DTACK Low to DS in High	totlosh	İ	0		0		0		
26 REQ Low to BR Low trelbru 250 200 160 ns 27 Clock High to BR Low tchbru 70 60 55 ns 28 Clock High to BR High tchbru 70 60 55 ns 29 BG Low to BGACK Low tbglb 4.5 4.5 4.5 clk.per. 30 BR Low to MPU Cycle End (AS in High) tbglb 0			tREQL		2.0	-+	2.0			+	
27 Clock High to BR Low tchbr. 70 60 55 ns 28 Clock High to BR High tchbr. 70 60 55 ns 29 BG Low to BGACK Low tbglb. 4.5 4.5 4.5 clk.per. 30 BR Low to MPU Cycle End (AS in High) tbglb. 0 <td>26</td> <td>REQ Low to BR Low</td> <td>trelbrl</td> <td>j</td> <td>250</td> <td></td> <td>200</td> <td></td> <td></td> <td></td> <td></td>	26	REQ Low to BR Low	trelbrl	j	250		200				
28 Clock High to BR High tchbre 70 60 55 ns 29 BG Low to BGACK Low tbglbl 4.5 4.5 4.5 clk.per. 30 BR Low to MPU Cycle End (AS in High) tbglbl 0 0 0 0 0 0	27		tCHBRL			70		60	-+	55	
29 BG Low to BGACK Low to BGACK Low to BGLBL 4.5 4.5 clk.per.	28		tснвкн	ľ		70		-+	-+		
30 BR Low to MPU Cycle End (AS in High)	29	BG Low to BGACK Low	tBGLBL	ŀ	4.5		4.5	+	4.5		
	30	BR Low to MPU Cycle End (AS in High)	tBRLASH	ŀ	0				0		ns ns

(continued next page)



MPU Cycle End (AS in High) to BGACK Low	No.	ltem	Symbol	Test Condition	8M Vers		10N Vers		12.5 Vers		Unit
2 REQ (Low to BGACK Low				Condition	min	max	min	max	min	max	
32 REQ Low to BGACK Low teleglat	31	MPU Cycle End (AS in High) to BGACK Low	tashbl		4.5	5.5	4.5	5.5	4.5	5.5	clk.per.
33 Clock High to BGACK Low	$\overline{}$		tREQLBL	1	6.5		6.5		6.5		clk.per.
34 Clock High to BGACK High Impedance to Loaz to Clock Low to BGACK High Impedance to Loaz to Clock High to Address Valid to Horvor to Clock High to Address/FC/Data Invalid to Horvor to Clock High to Madress/FC/Data Invalid to Horvor to Clock High to Madress/FC/Data Invalid to Horvor to Clock High to UAS Low to Address High Impedance to Louz to Clock High to UAS Low to LOAS High Impedance to Louz to Clock High to UAS High Impedance to Louz to Clock High to Address Invalid to Horvor to Horvor to Clock High to R/W High Impedance to Loaz to Horvor to R/W High Impedance to Loaz to Clock Low to R/W High Impedance to Loaz to Clock Low to R/W High Impedance to Loaz to Clock Low to R/W High Impedance to Loaz to Clock Low to R/W High Impedance to Loaz to Clock Low to R/W High Impedance to Loaz to R/W Low to BGACK Low to Clock Low to R/W High Impedance to Loaz to Clock Low to R/W High Impedance to Loaz to R/W Low to BGACK Low to Clock Low to R/W High Impedance to Loaz to R/W Low to BGACK Low to Clock Low to R/W High Impedance to Loaz to R/W Load to R/W Low to BGACK Low to Clock Low to R/W High Impedance to Loaz to R/W Load to R/W Low to BGACK Low to Clock Low to			tchBL	1		70	-	60		55	ns
35 Clock Low to BGACK High Impedance tolaz			tснвн	1		70		60		55	ns
36 Clock High to FC Valid Cohecv 37 Clock High to Address Valid Clock High to Address Valid Clock High to Address FC/Data High Impedance 40 Clock High to Address F(C/Data Invalid Clock Address Figh Impedance 41 Clock High to UAS Low Clock Low to Address High Impedance 42 Clock Ligh to UAS Low Clock Low to UAS High Impedance 43 Clock Low to UAS High Impedance Clock Address High Impedance 44 UAS High to Address Invalid Clock Low to UAS High Impedance 45 Clock Low to DS Low (write) Clock Low to AS, DS High Impedance 46 Clock Low to DS Low (write) Clock Low to AS, DS High Impedance 47 Clock Low to AS, DS High Impedance Clock Low to AS, DS High Impedance 48 Clock Low to AS, DS High Impedance Clock Low to AS, DS High Impedance 50 DS Width Low Clock Low to AS, DS High Impedance Clock Low to AS, DS High Impedance 51 AS, DS Width High Clock Low to AS, DS High Impedance Clock Low to AS, DS Low Clock Low to DS Low Clock Low to Cown Low Clock Low to Town High Clock Low to Town High Clock Low to Town High Clock Low to Hight Low Clock Low to Hight Low Clock Low to Hight Low Clock			tclbz	1		80		70		65	ns
33 Clock High to Address/FC/Data High Impedance ChuAz			tchfcv	_		100		90		90	ns
38 Clock High to Address/FC/Data High Impedance towaz			tchav			120		110		100	ns
39 Clock High to Address/FC/Data Invalid Colux Clock Low to Address High Impedance Colux Clock High to UAS Low Clock High to UAS High Clock High to UAS DS High Clock High to AS, DS Low Clock High to R/W High Clock High to ACK Low Clock Low to DWN High Clock High to ACK Low Clock High to ACK Low Clock High to ACK Low Clock High to ACK High Clock High to ACK High Clock High to High TELow Clock Low to HiBYTE Low Clock Low to HiBYTE Low Clock High to HiBYTE High Clock High to Clock High to HiBYTE Low Clock High to HiBYTE High Clock High to Clock High to HiBYTE Low Clock High to HiBYTE High Clock High to HiBYTE High Clock Hig			tchazx	1		100		100		100	ns
40 Clock Low to Address High Impedance tcluz 41 Clock High to UAS Low tchulu 42 Clock High to UAS High tight tchulu 43 Clock Low to UAS High Impedance tcluz 44 UAS High to Address Invalid tuhai 45 Clock High to AS, DS Low tchsi. 46 Clock Low to DS Low (write) tclost 47 Clock Low to DS Low (write) tclost 48 Clock Low to AS, DS High Impedance tclist 49 AS Width Low to S Width Low to S Width Low 50 DS Width Low to S Width Low to S Width Low 51 AS, DS Width High tsh 52 Address/FC Valid to AS, DS Low tchal 53 AS, DS High to Address/FC/Data Invalid tshaz 55 Clock High to R/W High tchar 55 Clock Low to R/W High Impedance tclaz 57 Address/FC Valid to R/W Low tchar 58 R/W Low to DS Low (write) tshar 59 DS High to R/W High tshar 60 Clock Low to OWN Low tclou 61 Clock Low to OWN High tshar 62 Clock High to R/W High tshar 63 OWN Low to BGACK Low tchol 64 BGACK High to OWN High tshar 65 OWN Low to UAS Low tchol 66 Clock High to ACK Low tchol 67 Clock Low to ACK Low tchac 68 Clock High to ACK High to ACK High to CK High 69 ACK Low to BS Low third tshar 70 60 55 red High to ACK High 70 60 55 red High 70			tCHAZn	1	0		0		0		ns
1 Clock High to UAS Low tchul.			tclaz	7		100		90		80	ns
42 Clock High to UAS High 43 Clock Low to UAS High Impedance 44 UAS High to Address Invalid 44 UAS High to Address Invalid 45 Clock Low to DS Low (write) 46 Clock Low to DS Low (write) 47 Clock Low to AS, DS High 48 Clock Low to AS, DS High Impedance 49 AS Width Low 49 AS Width Low 50 DS Width Low 51 AS, DS Width High 52 Address/FC Valid to AS, DS Low 53 AS, DS High to Address F/C/Data Invalid 54 Clock High to R/W High 55 Clock High to R/W High 56 Clock Low to R/W High Impedance 57 Address/FC Valid to R/W Low 58 R/W Low to DS Low (write) 59 DS High to R/W High 60 Clock Low to OWN Low 61 Clock Low to OWN Low 62 Clock Low to OWN Low 63 OWN Low to UAS Low 64 BGACK High to OWN High 65 OWN Low to DS Low 66 Clock High to ACK Low 67 Clock Low to TACK Low 68 Clock High to ACK Low 69 ACK Low to DS Low 69 ACK Low to HIBYTE Low 70 Goo S5 In 70			tchuL	1		70		60		55	ns
43 Clock Low to UAS High Impedance toluz 44 UAS High to Address Invalid turks 45 Clock High to AS, DS Low tolus 46 Clock Low to DS Low (write) tolus 47 Clock Low to DS Low (write) tolus 48 Clock Low to AS, DS High tolus 49 AS Width Low tolus 50 DS Width Low tolus 51 AS, DS Width High tolus 52 Address/FC Valid to AS, DS Low tavs 53 AS, DS High to Address/FC/Data Invalid tshaz 54 Clock High to R/W Low tolus 55 Clock High to R/W High tolus 56 Clock Low to DS Low (write) trus 57 Address/FC Valid to R/W Low tolus 58 R/W Low to DS Low (write) trus 59 DS High to ACW High tshrip 60 Clock Low to DWN High tolus 60 Clock Low to OWN High tolus 60 Clock Low to OWN High tolus 60 Clock Low to DWN High tolus 60 Clock High to ACK Low tolus 60 Tolus tolus 60 Tolus tolus tolus 70 Tolus tolus tolus 70 Tolus tolus tolus 70 Tolus			tснин			70		60		55	ns
44 UAS High to Address Invalid tuhal 45 Clock High to AS, DS Low tchst 46 Clock Low to DS Low (write) tclost 47 Clock Low to AS, DS High tcssh 48 Clock Low to AS, DS High Impedance tclsz 49 AS Width Low tast 50 DS Width Low tast 51 AS, DS Width High tsh 52 Address/FC Valid to AS, DS Low tavst 53 AS, DS High to Address/FC/Data Invalid tshaz 54 Clock High to ACK W High the High 55 Clock High to R/W High tchritten 56 Clock Low to DS Low (write) tshin to R/W Low to BS Low 57 Address/FC Valid to R/W Low tchritten 58 R/W Low to DS Low (write) trust 59 DS High to R/W High tshin the High 60 Clock Low to DWN Low tclou 61 Clock Low to DWN Low tclou 62 Clock High to DWN High teloh 63 DWN Low to BGACK Low to Lou 64 BGACK High to DWN High teloh 65 DWN Low to BTACK Low tclou 66 Clock High to ACK Low tclou 67 Clock Low to DS Low tclou 68 Clock High to ACK Low tclack 69 ACK Low to DS Low tclou 60 Clock High to ACK High tchach 61 Clock High to ACK High tchach 62 Clock High to ACK High tchach 63 DWN Low to BGACK Low tclack 64 BGACK High to ACK Low tclack 65 Clock High to ACK High tchach 66 Clock High to ACK High tchach 67 Clock Low to DS Low tclack 68 Clock High to ACK High tchach 69 ACK Low to TS Low tclack 60 Clock High to ACK High tchach 70 60 55 red to the High tellow tchall 70 60 55 red to the High tellow tchall 70 60 55 red to the High tellow tchall 70 60 55 red to the High tellow tchall 70 60 55 red to the High tellow tchall 70 60 55 red to the High tellow tchall 70 60 55 red to the High tellow tchall 70 60 55 red to the High tellow tchall 70 60 55 red to the High tellow tchall 70 60 55 red to the High tellow tcha			tcluz			80		70		65	ns
10			tuhai		30		20		15		ns
1	45	Clock High to AS, DS Low	tchsl			60		55		55	ns
47 Clock Low to AS, DS High toLish 48 Clock Low to AS, DS High Impedance toLisz 49 AS Width Low toSt 50 DS Width Low toSt 51 AS, DS Width High toSt 52 Address/FC Valid to AS, DS Low toValid 53 AS, DS High to Address/FC/Data Invalid tsHAZ 54 Clock High to R/W Low toHRL 55 Clock High to R/W High toHRH 56 Clock Low to R/W High Impedance toLinz 57 Address/FC Valid to R/W Low taval 58 R/W Low to DS Low (write) talsk 59 DS High to R/W High tsHRH 60 Clock Low to OWN High tsHRH 61 Clock Low to OWN High toLioh 62 Clock High to OWN High tsHOD 63 OWN Low to BGACK Low toList 64 BGACK High to OWN High tsHOD 65 OWN Low to TACK Low toLiat 66 Clock High to ACK Low toLiat 67 Clock Low to To Tack Low toLiat 68 Clock High to ACK High toACK Low 69 ACK Low to DS Low toLiat 60 Clock High to ACK High toACK High toACK High 70 Clock High to Tack High toLiah 70 Clock High to HibYTE Low toHHIL 70 Clock High to HibYTE High toHHIL 70 C	46	Clock Low to DS Low (write)	tcldsl	1		60		55		55	ns
## AS Width Low	47		tclsh	7		70		60		60	ns
190	48	Clock Low to AS, DS High Impedance	tcLsz	7		80		70		65	ns
51 AS, DS Width High 15H 150 105 65 10 105	49	AS Width Low	tası	1	255		195		160		ns
State	50	DS Width Low	tosı	7	190		145		120		ns
52 Address/FC Valid to ĀS, DS Low tavsl. 53 ĀS, DS High to Address/FC/Data Invalid tshaz 54 Clock High to R/W Low tchrkl. 55 Clock High to R/W High tchrkl. 56 Clock Low to R/W High Impedance tcl.RZ 57 Address/FC Valid to R/W Low tavrkl. 58 R/W Low to DS Low (write) trl.st. 59 DS High to R/W High tshrkl 60 Clock Low to Town High tshrkl 60 Clock Low to Town High tclot 61 Clock High to Town High Inpedance tchoz 62 Clock High to Town High tshoh 62 Clock High to Town High tshoh 64 BGACK High to Town High tshoh 65 OWN Low to UAS Low toluk 66 Clock High to ACK Low tchack 67 Clock Low to ACK Low tchack 70 60 55 68 Clock High to ACK High tchack 70 60 55	51	AS, DS Width High	tsн	٦	150		105		65		ns
S3 AS, DS High to Address/FC/Data Invalid tshaz			tavsl	Figurel	30		20	-	0		ns
To be described by the color of the color		AS, DS High to Address/FC/Data Invalid	tshaz	7	30		20		15		ns
Solution Figure	54		tchrl	7 ~		70		60		55	ns
Society Soci	55	Clock High to R/W High	tchrh	1		70		60		55	ns
58 R/W Low to DS Low (write) trls. 59 DS High to R/W High tshrh 60 Clock Low to OWN Low tclol 61 Clock Low to OWN High tcloh 62 Clock High to OWN High Inpedance tchoz 63 OWN Low to BGACK Low tolbl 64 BGACK High to OWN High tbhoh 65 OWN Low to UAS Low tolul 66 Clock High to ACK Low tolul 67 Clock Low to ACK Low tchacl 68 Clock High to ACK High tchacl 70 60 55 69 ACK Low to DS Low taclosl 70 50 55 70 60 55 69 ACK Low to DS Low taclosl 70 60 55 71 Clock High to HIBYTE Low tchhill 72 Clock Low to HIBYTE Low tchhill 73 Clock High to HIBYTE High tchhill	56	Clock Low to R/W High Impedance	tclrz	Figures		80		70		65	ns
So No No No No No No No	57	Address/FC Valid to R/W Low	tavrl	7	20		10		0		ns
60 Clock Low to OWN Low toLou	58	R/W Low to DS Low (write)	trlsl	7	120		90		70		ns
61 Clock Low to OWN High 62 Clock High to OWN High Inpedance 63 OWN Low to BGACK Low 64 BGACK High to OWN High 65 OWN Low to UAS Low 66 Clock High to ACK Low 67 Clock Low to ACK Low 68 Clock High to ACK High 69 ACK Low to DS Low 70 Edo 71 Clock High to HIBYTE Low 72 Clock Low to HIBYTE Low 73 Clock High to HIBYTE High 74 EdhHill 75 Edo 76 Edo 77 Edo 78 Edo 79 Edo 70 Edo 70 Edo 70 Edo 70 Edo 70 Edo 71 Edo 72 Clock Low to HIBYTE Low 74 EdhHill 75 Edo 75 Edo 76 Edo 77 Edo 78 Edo 79 Edo 70 Edo 70 Edo 70 Edo 70 Edo 71 Edo 72 Edo 73 Clock High to HIBYTE High 70 Edo 75 Edo 76 Edo 77 Edo 78 Edo 79 Edo 79 Edo 70 Edo 71	59	DS High to R/W High	tshrh	7	40		20		15		ns
62 Clock High to OWN High Inpedance tcHoz 80 70 65 m 63 OWN Low to BGACK Low toLBL 30 20 15 m 64 BGACK High to OWN High tbHoH 30 20 15 m 65 OWN Low to UAS Low toLUL 30 20 15 m 66 Clock High to ACK Low tcHacL 70 60 55 m 67 Clock Low to ACK Low tcHach 70 60 55 m 68 Clock High to ACK High tcHach 70 60 55 m 69 ACK Low to DS Low tacLDSL 100 80 60 m 70 DS High to ACK High toHBYTE Low tcHall 70 60 55 m 72 Clock Low to HIBYTE Low tcHall 70 60 55 m 73 Clock High to HIBYTE High tcHall 70 60 55 m	60	Clock Low to OWN Low	tCLOL			70		60		55	ns
63 OWN Low to BGACK Low 64 BGACK High to OWN High 65 OWN Low to UAS Low 66 Clock High to ACK Low 67 Clock Low to ACK Low 68 Clock High to ACK High 69 ACK Low to DS Low 70 Edo 55 m 70 Edo 55 m 70 Edo 55 m 71 Clock High to ACK High 72 Clock Low to HIBYTE Low 73 Clock High to HIBYTE Low 74 Clock High to HIBYTE High 75 Clock High to HIBYTE High 76 Edo 55 m 77 Clock High to HIBYTE High 78 Clock High to HIBYTE High 79 Edo 55 m 70 Edo 55 m 70 Edo 55 m 70 Edo 55 m 71 Clock High to HIBYTE Low 72 Clock Low to HIBYTE Low 73 Clock High to HIBYTE High 75 Edo 55 m 76 Edo 55 m 77 Clock High to HIBYTE High	61	Clock Low to OWN High	tcloH	7		70		60		55	ns
64 BGACK High to OWN High 15 15 16 15 17 15 17 15 17 15 17 15 17 15 17 15 17 15 17 15 17 15 17 15 17 15 17 15 17 15 17 16 15 17 15 17 16 15 17 16 15 17 16 15 17 16 15 17 16 15 17 17 17 16 15 17 17 17 17 17 17 18<	62	Clock High to OWN High Inpedance	tсноz			80		70		65	ns
65 OWN Low to UAS Low to LOUL 30 20 15 m 66 Clock High to ACK Low to LOUL 70 60 55 m 67 Clock Low to ACK Low to LOUL 70 60 55 m 68 Clock High to ACK High to LOUL 70 60 55 m 69 ACK Low to DS Low taclost 100 80 60 m 70 DS High to ACK High to LOUND 15 m 71 Clock High to HIBYTE Low to LOUND 15 m 72 Clock Low to HIBYTE Low to LOUND 160 55 m 73 Clock High to HIBYTE High to HIBYTE High to LOUND 160 55 m 74 Clock High to HIBYTE High to HIBYTE High 150 m 75 Clock High to HIBYTE High 150 m 76 Clock High to HIBYTE High 150 m 77 Clock High to HIBYTE High 150 m 78 Clock High to HIBYTE High 150 m 79 Clock High to HIBYTE High 150 m 70 FOR THE HI	63	OWN Low to BGACK Low	tolbl		30		20		15		ns
66 Clock High to ACK Low tchacl 70 60 55 m 67 Clock Low to ACK Low tclacl 70 60 55 m 68 Clock High to ACK High tchach 70 60 55 m 69 ACK Low to DS Low taclosl 100 80 60 m 70 DS High to ACK High toshach 30 20 15 m 71 Clock High to HIBYTE Low tchhill 70 60 55 m 72 Clock Low to HIBYTE Low tclhil 70 60 55 m 73 Clock High to HIBYTE High tchhilh 70 60 55 m	64	BGACK High to OWN High	твнон		30		20		15		ns
67 Clock Low to ACK Low 68 Clock High to ACK High 69 ACK Low to DS Low 70 DS High to ACK High 70 BS High to ACK High 70 DS High to ACK High 70 DS High to ACK High 71 Clock High to HIBYTE Low 72 Clock Low to HIBYTE Low 73 Clock High to HIBYTE High 74 Clock High to HIBYTE High 75 TCHHIL 76 GO TS TREE 77 TO	65	OWN Low to UAS Low	toLUL		30		20		15		ns
68 Clock High to ACK High 69 ACK Low to DS Low 100 80 60 70 70 DS High to ACK High 100 80 60 70 71 Clock High to HIBYTE Low 72 Clock Low to HIBYTE Low 73 Clock High to HIBYTE High 100 80 60 70 100 80 60 70 100 80 60 70 100 80 60 70 100 80 60 70 100 80 60 70 100 80 60 70 100 80 60 70 100 80 60 70 100 80 60 70 100 80 60 70 100 80 60 70 100 80 80 60 70 100 80 80 60 70 100 80 80 60 80 100 80 80 80 100 80 80 80 100 80 80 80 100 80 80 80 100 80 80 80 100 80 80 80 100 80 80 100 80 80 100 80 80 100 80 80 100 80 80 100 80 80 100 80 100 80 80 10	66	Clock High to ACK Low	t CHACL			70		60		55	ns
69 ACK Low to DS Low tacldsl 100 80 60 region 70 DS High to ACK High tdshach 30 20 15 region 71 Clock High to HIBYTE Low tchhil 70 60 55 region 72 Clock Low to HIBYTE Low tchhil 70 60 55 region 73 Clock High to HIBYTE High tchhilh 70 60 55 region	67	Clock Low to ACK Low	tCLACL			70		60		55	ns
70 DS High to ACK High toshach 30 20 15 r 71 Clock High to HIBYTE Low tchhil 70 60 55 r 72 Clock Low to HIBYTE Low tchil 70 60 55 r 73 Clock High to HIBYTE High tchhilh 70 60 55 r	68	Clock High to ACK High	tchach			70		60		55	ns
71 Clock High to HIBYTE Low tchHiL 70 60 55 r 72 Clock Low to HIBYTE Low tcLHiL 70 60 55 r 73 Clock High to HIBYTE High tcHHiH 70 60 55 r	69	ACK Low to DS Low	TACLDSL		100		80		60		ns
72 Clock Low to HIBYTE Low tchill 70 60 55 г 73 Clock High to HIBYTE High tchill 70 60 55 г	70	DS High to ACK High	toshach		30		20		15		ns
73 Clock High to HIBYTE High tchHiH 70 60 55 r	71	Clock High to HIBYTE Low	tснніг			70		60		55	ns
73 Glock right to the FTE Fight	72	Clock Low to HIBYTE Low	tclHIL			70		60		55	ns
74 Clock Low to HIBYTE High Impedance tcLHIZ 80 70 65 r	73	Clock High to HIBYTE High	tсннін			70		60		55	ns
	74	Clock Low to HIBYTE High Impedance	tcLHIZ			80		70	<u> </u>	65	ns
75 Clock High to DTC Low tcHDTL 70 60 55 r	75	Clock High to DTC Low	tCHDTL			70		60	<u> </u>	55	ns
76 Clock High to DTC High tcнотн 70 60 55 г	76	Clock High to DTC High	tснотн			70	<u> </u>	60	<u> </u>	55	ns

(continued next page)



No.	Item	Symbol	Test Condition	Va	MHz rsion		MHz rsion	1	5MHz rsion	Unit
77	Clock Low to DTC High Impedance			min	max		max	min	max	
78	DTC Width Low	tCLDTZ	4		80	+	70		65	ns
79	DTC Low to DS High	totcl	4	105	 	80		60		ns
80	Clock High to DONE Low	totloh	4	30	ļ	20	 	15		ns
81	Clock Low to DONE Low	tchdol	4		70		60		55	ns
82	Clock High to DONE High	tCLDOL	-	ļ	70		60		55	ns
83		tсноон	_		130		120		120	ns
84	Clock Low to DDIR High Impedance	tcldrz	_		80		70		65	ns
85	Clock Low to DBEN High Impedance	tcldbz	_		80	<u> </u>	70		65	ns
86		TORLOBL		30		20		15		ns
	DBEN High to DDIR High	tobhorh	1	30		20		15		ns
87	DBEN Low to Address/Data High Impedance	TOBLAZ	1		17		17		17	ns
88	Clock Low to PCL Low (1/8 clock)	tCLPL	1		70		60		55	ns
89	Clock Low to PCL High (1/8 clock)	tclph	Figure1		70		60		55	ns
90	PCL Width Low (1/8 clock)	tPCLL		4.0		4.0		4.0		clk.per.
91	DTACK Low to Data In (setup time)	TDALDI	~		150		115		85	ns
92	DS High to Data Invalid (hold time)	tshDi		0		0		0		ns
93	DS High to DTACK High	tshdah	Figure8	0	120	0	90	0	70	ns
94	Data Out Valid to DS Low	toosl]	0		0		0		ns
95	Data In to Clock Low (setup time)	tDICL		15		15		15		ns
96	BEC Low to DTACK Low	TBECDAL]	50		50		50		ns
97	BEC Width Low	TBECL] [2.0		2.0		2.0		clk.per.
98	Clock High to IRQ Low	tchirl	1		70		60		55	ns
99	Clock High to IRQ High	tchirh			130		120		120	ns
100	READY In to DTC Low (Read)	TRALDTL		145		120		100		ns
101	READY In to DS Low (Write)	TRALDSL	1 †	205				140	1	ns
102	DS High to READY High	toshrah		0 120 0 90			0	70	ns ns	
103	DONE In Low to DTACK Low	TOOLDAL		50				50		ns
104	DS High to DONE In High	toshooh		0				0	70	ns
105	Asynchronous Input Hold Time	tasih		15		15		15		ns

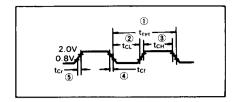


Figure 2 Input Clock Waveform

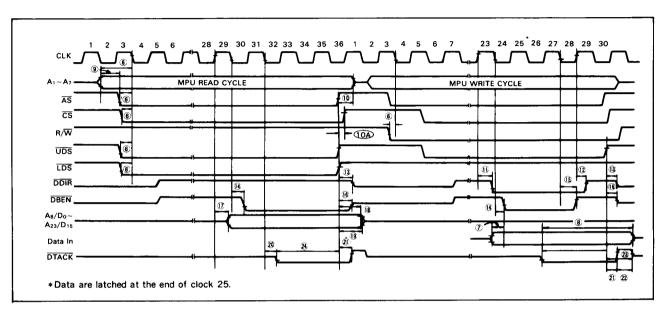


Figure 3 AC Electrical Waveforms-MPU Read/Write

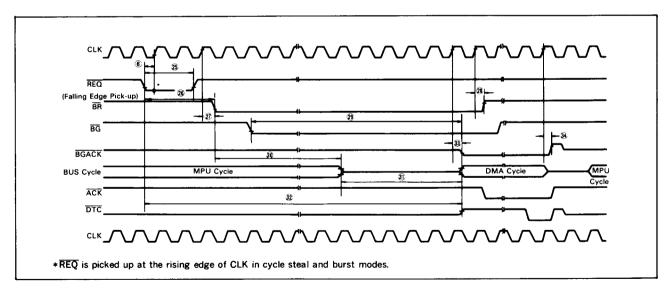


Figure 4 AC Electrical Waveforms-Bus Arbitration

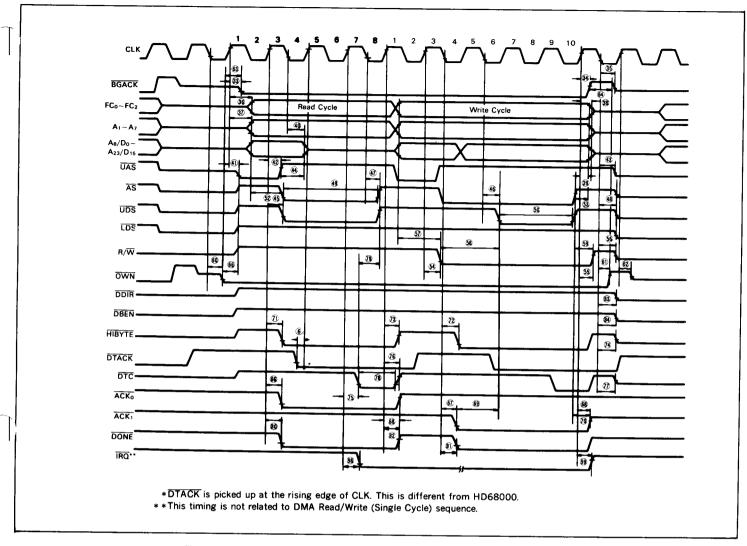


Figure 5 AC Electrical Waveforms-DMA Read/Write (Single Cycle)

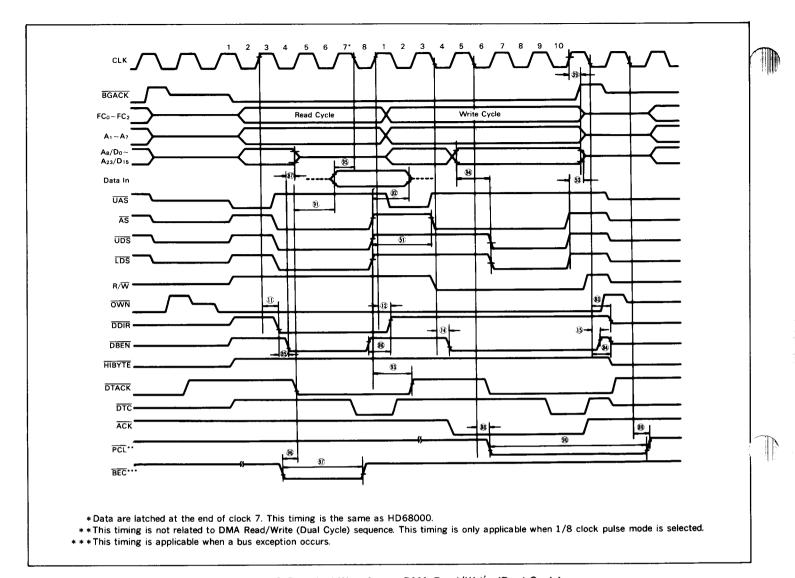


Figure 6 AC Electrical Waveforms-DMA Read/Write (Dual Cycle)

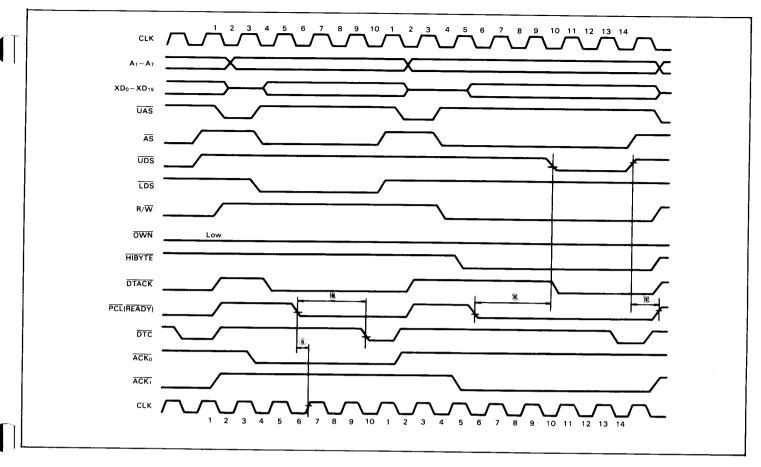


Figure 7 AC Electrical Waveforms-DMA Read/Write (Single Cycle with ACK and READY)

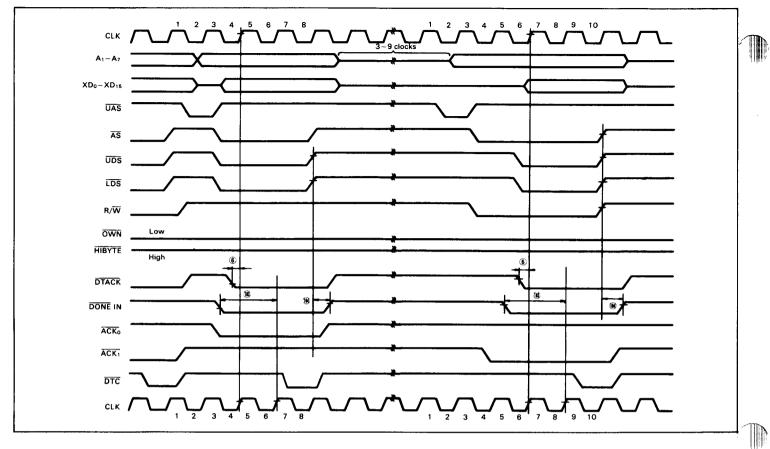


Figure 8 AC Electrical Waveforms-DONE Input

(NOTES for Figure 3 through 8)

- 1) Setup time for the asynchronous inputs BG, BGACK, CS, IACK, AS, UDS, LDS, and R/W guarantees their recognition at the next falling edge of the clock. Setup time for BEC0~BEC2, REQ0~REQ3, PCL0~PCL3, DTACK, and DONE guarantees their recognition at the next rising edge of the clock.
- 2) Timing measurements are referred to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts.
- 3) These waveforms should only be referred in regard to the edge-to-edge measurement of the timing specifications. They are not intended as a functional description of the input and output signals. Refer to other functional descriptions and their related diagrams for device operation.



■ INTRODUCTION

The main purpose of a direct memory access (DMA) controller is to perform memory-to-memory, device-to-memory, and memory-to-device data transfers at high speed. The DMAC is required in any system including the device for data input/output like a floppy disk, a hard disk, a display terminal etc..

Figure 9 illustrates a typical system configuration using the DMAC. In this figure, the DMAC transfers blocks of data between the HDC and memory in a quick and efficient manner. Memory-to-memory data transfer is also provided by using data registers in the DMAC. Both 8-bit and 16-bit I/O devices are supportable. 8-/16-/32-bit data can be accessed in the DMA data transfer.

OPERATION MODES

The HD63450 DMAC operates through the MPU's writing operation into the internal control registers, then the DMAC will be in one of three operating modes:

.) MPU mode

This is the state that the DMAC is chip-selected by another bus master in the system (MPU etc.), or that it is asserting the vector number during the interrupt acknowledge cycle.

DMA mode

This is the state that the DMAC is acting as a bus master to perform an operand transfer. The DMA bus cycle refers to the bus cycle that is executed by the DMAC in the DMA mode.

3) IDLE mode

This is the state that the DMAC is reset by an external device. The DMAC is waiting for an access by MPU or an operand transfer request from a peripheral. Many of the bus control signals are three-stated.

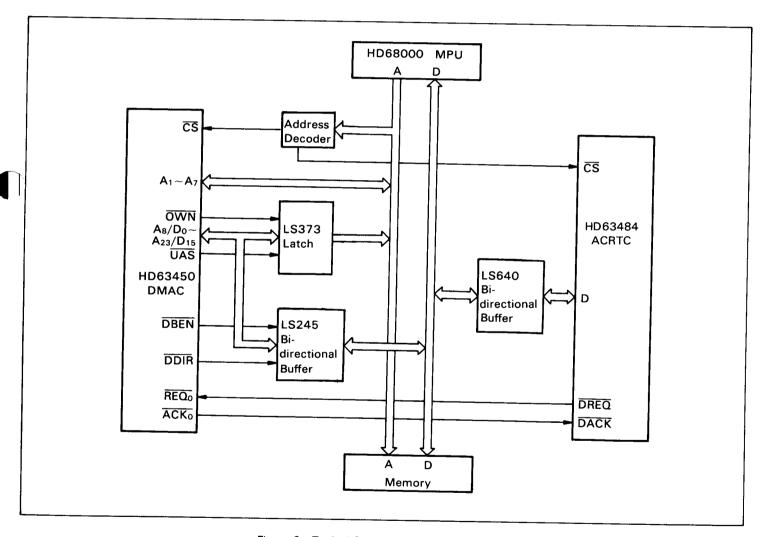


Figure 9 Typical System Configuration



■ SIGNAL DESCRIPTION

In this data sheet, the state of the signals is described with "active/inactive" or "assert/negate".

Figure 10 illustrates the input and output signals. Each function is described in the following.

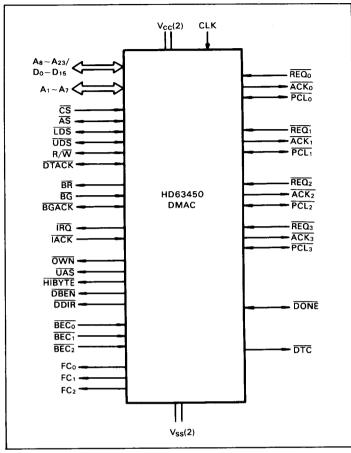


Figure 10 Input and Output Signals

Address/Data Bus (A₈/D₀ through A₂₃/D₁₅)

Input/Output Three-statable

These lines are time multiplexed for address and data bus. The lines \overline{DDIR} , \overline{DBEN} , \overline{UAS} and \overline{OWN} are used to control the demultiplexing of the data and address lines externally. Demultiplexing is explained in the later section. The bidirectional data bus is used to transfer data between DMAC, MPU, memory and I/O devices.

Address lines are outputs to address memory and I/O devices.

◆Address Bus (A₁ through A₂)

Input/Output Three-statable

In the MPU mode, the DMAC internal registers are accessed with these lines and \overline{LDS} , \overline{UDS} . The address map for these registers is shown in Table 1. During a DMA bus cycle, A_1 - A_7 are outputs containing the low order address bits of the location being accessed.

● Function Code (FC₀ through FC₂)

Output Three-statable

These output signals provide the function codes during DMA bus cycles. They are three-stated except in the DMA bus cycles. They are used to control the HD68000 memories.

• Clock (CLK)

Input

This is the input clock to the HD63450, and should never be terminated at any time. This clock can be different from the MPU clock since HD63450 operates completely asynchronously.

◆ Chip Select (CS)

Input

This input signal is used to chip select the DMAC in "MPU" mode. If the CS input is asserted during a bus cycle which is generated by the DMAC, the DMAC internally terminates the bus cycle and signals an address error. This function protects the DMAC from accessing its own register.

● Address Strobe (AS)

Input/Output

Three-statable

In the "MPU mode", this line is an input indicating valid address input, and during the DMA bus cycle it is an output indicating valid address output from the DMAC on the address bus

The DMAC monitors these input lines during bus arbitration to determine the completion of the bus cycle by the MPU or other bus masters

● Upper Address Strobe (UAS)

Output

Three-statable

This line is an output to latch the upper address lines on the multiplexed data/address lines. It is three-stated except in the "DMA mode".

●Own (OWN)

Output

Three-statable

This line is asserted by the DMAC during DMA mode, and is used to control the output of the address line latch. This line may also be used to control the direction of bi-directional buffers when loads on \overline{AS} , \overline{LDS} , \overline{UDS} , R/W and other signals exceed the drive capability. It is three-stated in the "MPU mode" and the "IDLE mode".

● Data Direction (DDIR)

Output

Three-statable

This line controls the direction of data through the bi-directional buffer which is used to demultiplex the data/address lines. It is three-stated during the "IDLE mode".

Data Bus Enable (DBEN)

Output

Three-statable

This line controls the output enable line of bi-directional buffers on the multiplexed data/address lines. It is three-stated during the "IDLE mode".

● High Byte (HIBYTE)

Output

Three-statable

This line is used when the operand size is byte in the single addressing mode. It is asserted when data is present on the upper eight bits of the data bus. It is used to control the output of bidirectional buffers which connects the upper eight bits of the data bus with the lower eight bits. It is three-stated during the "MPU mode" and the "IDLE mode".



● Read/Write (R/W)

Input/Output

Three-statable

This line is an input during the "MPU mode" and an output during the "DMA mode". It is three-stated during the "IDLE mode". It is used to control the direction of data flow.

● Upper Data Strobe (UDS), Lower Data Strobe (LDS)

Input/Output

Three-statable

These lines are extensions of the address lines indicating which byte or bytes of data of the addressed word are being addressed. These lines combined corresponds to address line A_{0} in table 1.

● Data Transfer Acknowledge (DTACK)

Input/Output

Three-statable

In the "MPU mode", this line is an output indicating the completion of Read/Write bus cycle by the MPU.

In the "DMA mode", the DMAC monitors this line to determine when a data transfer has completed. In the event that a bus exception is requested, except for \overline{HALT} , prior to or concurrent with \overline{DTACK} , the \overline{DTACK} response is ignored and the bus exception is honored. In the "IDLE mode", this signal is three-stated.

■ Bus Exception Controls (BEC₀ through BEC₂)

Input

These lines provide an encoded signal input indicating an exceptional condition in the DMA bus cycle. See bus exception section for details.

● Bus Request (BR)

Output

This output line is used to request ownership of the bus by the DMAC.

● Bus Grant (BG)

Input

This line is used to indicate to the DMAC that it is to be the next bus master. The DMAC cannot assume bus ownership until both \overline{AS} and \overline{BGACK} become inactive. Once the DMAC acquires the bus, it dose not continue to monitor the \overline{BG} input.

Bus Grant Acknowledge (BGACK)

Input/Output

Three-statable

Bus Grant Acknowledge (BGACK) is a bi-directional control line. As an output, it is generated by the DMAC to indicate that it is the bus master.

As an input, BGACK is monitored by the DMAC, in limited rate auto-request mode, to determine whether or not the current bus master is a DMA device or not. BGACK is also monitored during bus arbitration in order to assume bus ownership.

● Interrupt Request (IRQ)

Output

Open drain

This line is used to request an interrupt to the MPU.

● Interrupt Acknowledge (IACK)

Input

This line is an input to the DMAC indicating that the current bus cycle is an interrupt acknowledge cycle by the MPU. The DMAC responds the interrupt vector of the channel with the highest priority requesting an interrupt. There are two kinds of the interrupt vectors for each channel: normal (NIV) or error (EIV). IACK is not serviced if the DMAC has not generated IRQ.

● Channel Request (REQo through REO₃)

Input

These lines are the DMA transfer request inputs from the peripheral devices.

These lines are falling edge sensitive inputs when the request mode is cycle steal. They are low-level sensitive when the request mode is burst.

● Channel Acknowledge (ACK₀ through ACK₃)

Output

These lines indicate to the I/O device requesting a transfer that the request is acknowledged and the transfer is to be performed. These lines may be used as a part of the enable circuit for bus interface to the peripheral.

● Peripheral Control Line (PCL₀ through PCL₃)

Input/Output

Three-statable

The four lines (PCL₀~PCL₃) are multi-purpose lines which may be individually programmed to be a START output, an Enable Clock input, a READY input, an ABORT input, a STATUS input, or an INTERRUPT input.

 $\overline{REQ_x}$, $\overline{ACK_x}$, and $\overline{PCL_x}$ are provided for each channel.

● Done (DONE)

Input/Output

Open Drain

As an output, this line is asserted concurrently with the ACK_x timing to indicate the last data transfer to the peripheral device. As an input, it allows the peripheral device to request a normal termination of the DMA transfer.

● Device Transfer Complete (DTC)

Output

Three-statable

This line is asserted when the DMA bus cycle has terminated normally with no exceptions. It may be used to supply the data latch timing to the peripheral device. In this case, data is valid at the falling edge of \overline{DTC} .



■ INTERNAL ORGANIZATION

The DMAC has four independent DMA channels. Each channel has its own set of channel registers. These registers define and control the activity of the DMAC in processing a channel operation.

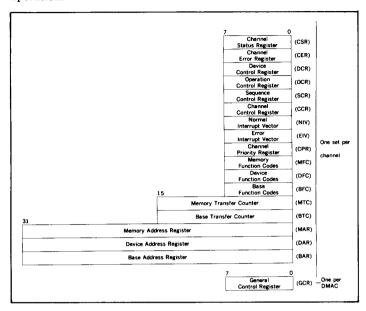


Figure 11 Internal Registers

Register Organization

The internal register addresses are represented in Table 1. Address space not used within the address map is reserved for future expansion. A read from an unused location in the map results in a normal bus cycle with all ones for data. A write to one of these locations results in a normal bus cycle but no write occurs.

Unused bits of the defined registers in Table 1 are read as zeros.

Table 1 Internal Register Addressing Assignments

Register		ddress		Mode
Channel Status Register			000	R/W*
Channel Error Register		000	001	R
Device Control Register		000		R/W
Operation Control Regis		000		R/W
Sequence Control Regist	•••	000		R/W
Channel Control Registe		000		R/W
Memory Transfer Count		001	I	R/W
Memory Address Regist		0.01	1 s s	R/W
Device Address Register		010		R/W
Base Transfer Counter		0 1 1		R/W
Base Address Register	,	0 1 1	1 s s	R/W
Normal Interrupt Vector			101	R/W
Error Interrupt Vector	- '	100		R/W
Channel Priority Registe	"	c 1 0 1		R/W
Memory Function Codes			001	R/W
Device Function Codes			001	R/W
Base Function Codes	6		001	R/W
General Control Registe	7 1	1111	1111	R/W
			· · · · ·	11,7 **
cc: ss	=	b:	0-High-ord	lor
00-Channel #0 01-Channel #1	00-High-order 01-Upper middle		1-Low-ord	

10-Lower middle

11-Low-order

*see Channel Status Register section in page 17

Device Control Register (DCR)

The DCR is a device oriented control register. The XRM bits specify whether the channel is in burst or cycle steal request mode. The DTYP bits define what type of device is on the channel. If the DTYP bits are programmed to be a HMCS6800 device, the PCL definition is ignored and the PCL line is an Enable clock input. If the DTYP bits are programmed to be a device with READY, the PCL definition is ignored and the PCL line is a READY input. The DPS bit defines the port size (eight or sixteen bits) of the peripheral device. (A port size is the largest data which the peripheral device can transfer during a DMA bus cycle.) The PCL bits define the function of the PCL line. If the DTYP bits are programmed to be HMCS6800 device, or Device with ACK and READY, these definitions are ignored. The XRM bits are ignored if an auto-request mode (REQG=00 or 01 in Operation Control Register) is selected.

7	6	5	4	3	2	1	0
XRM		DT	ΥP	DPS	0	P	CL

XRM (EXTERNAL REQUEST MODE)

- 00 Burst Transfer Mode
- 01 (undefined, reserved)
- 10 Cycle Steal Mode without Hold
- Cycle Steal Mode with Hold 11

DTYP (DEVICE TYPE)

- HD68000 compatible device, explicitly addressed 00 (dual addressing mode)
- 01 HD6800 compatible device, explicitly addressed (dual addressing mode)
- 10 Device with ACK, implicitly addressed (single addressing mode)
- Device with ACK and READY, implicitly addressed 11 (single addressing mode)

DPS (DEVICE PORT SIZE)

- 8 bit port
- 1 16 bit port

PCL (PERIPHERAL CONTROL LINE)

- Status Input
- 01 Status Input with Interrupt
- 1/8 Start Pulse
- 11 Abort Input

Bit 2 Not Used

Operation Control Register (OCR)

The OCR is an operation control register. The DIR bit defines the direction of the transfer. The BTD bit defines the execution of the multi-block transfer with DONE. The SIZE bits define the size of the operand. The CHAIN bits define the type of the CHAIN mode. The REQG bits define how requests for transfers are generated.

7	6	5	4	3	2	1	0
DIR	BTD	SI	ZE	СН	AIN	RE	EQG .

DIR (DIRECTION)

- Transfer from memory to device (transfer from MAR address to DAR address)
- Transfer from device to memory (transfer from DAR address to MAR address)



10-Channel #2

11-Channel #3

BTD (MULTI BLOCK TRANSFER WITH $\overline{\text{DONE}}$ MODE)

- 0 Terminates channel operation after the current DMA bus cycle completion
- 1 Restarts next block transfer after the current DMA bus cycle completion

See Page 47 Note 2 for details

SIZE (OPERAND SIZE)

- 00 Byte (8 bits)
- 01 Word (16 bits)
- 10 Long Word (32 bits)
- 11 Byte Transfer without Packing (Port size: 8 bits)

CHAIN (CHAINING OPERATION)

- 00 Chain operation is disabled
- 01 (undefined, reserved)
- 10 Array Chaining
- 11 Linked Array Chaining

REQG (DMA REQUEST GENERATION METHOD)

- On Auto-request at transfer rate limited by General Control Register (Limited Rate Auto-Request)
- 01 Auto-request at maximum rate
- 10 REQ line requests an operand transfer
- 11 Auto-request the first operand, external request for subsequent operands

See Page 47 Note 2 for details

Sequence Control Register (SCR)

The SCR is used to define the sequencing of memory and device addresses.

	6	5	4	3	2	1	0
0	0	0	0	M	AC	D/	AC

MAC (MEMORY ADDRESS COUNT)

- 00 Memory address register does not count
- 01 Memory address register counts up
- 10 Memory address register counts down
- 11 (undefined, reserved)

DAC (DEVICE ADDRESS COUNT)

- 00 Device address register does not count
- 01 Device address register counts up
- 10 Device address register counts down
- 11 (undefined, reserved)

Bits 7, 6, 5, 4 Not Used

● Channel Control Register (CCR)

The CCR is used to start or terminate the operation of a channel. This register also determines if an interrupt request is to be generated. Setting the STR bit causes immediate activation of the channel; the channel will be ready to accept request immediately. The STR and CNT bits of the register cannot be reset by a write to the register. The SAB bit is used to terminate the operation forcedly. Setting the SAB bit will reset STR and CNT. Setting the HLT bit will halt the channel operation, and clearing the HLT bit will resume the operation. Setting start bit must be done by byte access. Otherwise, timing error occurs.

	6	5	4	3	2	1	0
STR	CNT	HLT	SAB	INT	0	0	0

STR (START OPERATION)

- 0 No operation is pending
- 1 Start operation

CNT (CONTINUE OPERATION)

- 0 No continuation is pending
- 1 Continue operation

HLT (HALT OPERATION)

- 0 Operation not halted
- Operation halted

SAB (SOFTWARE ABORT)

- 0 Channel operation not aborted
- 1 Abort channel operation

INT (INTERRUPT ENABLE)

- 0 No interrupts enabled
- 1 Interrupts enabled

Bits 2, 1, 0 Not Used

● Channel Status Register (CSR)

The CSR is a register containing the status of the channel.

7	6	5	4	3	2	1	0
coc	втс	NDT	ERR	ACT	DIT	PCT	PCS

COC (CHANNEL OPERATION COMPLETE)

- 0 Channel operation incomplete
- 1 Channel operation complete

BTC (BLOCK TRANSFER COMPLETE)

- Block transfer incomplete
- 1 Block transfer complete

NDT (NORMAL DEVICE TERMINATION)

- 0 No normal device termination by DONE input
- 1 Device terminated operation normally by DONE input

ERR (ERROR BIT)

- 0 No errors
- 1 Error as coded in CER

ACT (CHANNEL ACTIVE)

- 0 Channel not active
- 1 Channel active

DIT (DONE INPUT TRANSITION)

- 0 No DONE input transition occurred
- DONE input transition occurred when BTD bit is set

PCT (PCL TRANSITION)

- 0 No PCL transition occurred
- 1 PCL transition occurred

PCS (THE STATE OF THE PCL INPUT LINE)

- 0 PCL "Low"
- 1 PCL "High"



◆ Channel Error Register (CER)

The CER is an error condition status register. The ERR bit of CSR indicates if there is an error or not. Bits 0-4 indicate what type of error has occurred.

7	6	5	4	3	2	1	0
0	0	0		ERI	ROR CC	DE	

Error Coc	le
00000	No error
00001	Configuration error
00010	Operation timing error
00101	Address error in MAR
00110	Address error in DAR
00111	Address error in BAR
01001	Bus error in MAR
01010	Bus error in DAR
01011	Bus error in BAR
01101	Count error in MTC
01111	Count error in BTC
10000	External abort
10001	Software abort

Bits 7, 6, 5 Not Used

● Channel Priority Register (CPR)

The CPR is used to define the priority level of the channel. Priority level 0 is the highest and priority level 3 is the lowest priority.

7	6	5	4	3	2	1 0
0	0	0	0	0	0	СР

CP (CHANNEL PRIORITY)

00 Priority level 0

01 Priority level 1

10 Priority level 2

11 Priority level 3

Bit 7 through 2 Not Used

• General Control Register (GCR)

The GCR is used to define what portion of the bus cycles is available to the DMAC for limited rate auto-request generation. GCR is also used to specify the hold time for cycle steal mode with hold.

7	6	5	4	3	2	1	0
0	0	0	0	В	T	В	BR .

BT (BURST TIME)

The number of DMA clock cycles per burst that the DMAC allows in the auto-request at a limited rate of transfer is controlled by these two bits. The number is 2(BT+4) (two to the BT +4 power).

ВТ	Clock Cycle
00	16 Clocks
01	32 Clocks
10	64 Clocks
11	128 Clocks

BR (BANDWIDTH RATIO)

The amount of the bandwidth utilized by the auto-request at a limited rate transfer is controlled by these two bits. The ratio is $2^{(BR+1)}$ (two to the BR+1 power).

BR	Bandwidth Ratio
00	50.00%
01	25.00%
10	12.50%
11	6.25%

The hold time for cycle steal mode with hold is defined to be minimum of 1 sample interval and maximum of 2 sample intervals. A sample interval is defined to be 2(BT+BR+5) (two to the BT+BR+5 power) clock cycles.

Bit 7 through 4 Not Used

• Address Registers (MAR, DAR, BAR)

Three 32-bit registers are utilized to implement the Memory Address Register, Device Address Register, and the Base Address Register. Only the least significant twenty-four bits are connected to the address output pins. The content of the MAR is outputted when the memory is accessed in single or dual addressing mode. The content of the DAR is outputted when the peripheral device is accessed. The contents of the BAR is outputted when reading chain information from memory in the Array Chaining Mode or the Linked Array Chaining Mode. It is also used to set the top address of the next block transfer in Continue mode.

◆ Function Code Registers (MFC, DFC, BFC)

The DMAC has three function code register per channel: the Memory Function Code Register (MFC), Device Function Code Register (DFC), and the Base Function Code Register (BFC). The contents of these registers are outputted from FCo through FCo lines when an address is outputted from MAR. DAR, or BAR, respectively. The BFC is also used to set the MFC for the transfer of the next data block in the Continue mode.

7	7	6	5	4	3	2	1	0
)	0	0	0	0	FC2	FC1	FC0

Bit 3 through 7 Not Used

● Transfer Count Registers (MTC, BTC)

Each channel has two 16-bit counters: the Memory Transfer Counter (MTC) and the Base Transfer Counter (BTC). The MTC counts the number of transfer words in one block, and is decreased by one for every operand transfer.

The BTC is used to count the number of data blocks in the Array Chaining Mode. BTC is also used to set the number of operands to transfer for the next data block in the Continue Mode.

The specifiable number is up to "216-1".

● Interrupt Vector Registers (NIV, EIV)

Each channel has a Normal Interrupt Vector register and an Error Interrupt Vector register.

When an interrupt acknowledge cycle occurs, an interrupt vector is outputted from one of those registers. If the error bit (CSR) is set for the channel with interrupt pending, then content of EIV is outputted, otherwise content of NIV is outputted.



■ OPERATION DESCRIPTION

A DMAC channel operation proceeds in three principal phases. During the initialization phase, the MPU sets the channel control registers, supplies the initial address and the number of transfer words, and starts the channel. During the transfer phase, the DMAC accepts requests for data operand transfers, and provides addressing and bus controls for the transfers. The termination phase occurs after the operation is completed.

This section describes DMAC operations. A description of the MPU/DMAC communication is given first. Next, the transfer phase is covered, including how the DMAC recognizes requests and how the DMAC arranges for data transfer. Following this, the initialization phase is described. The termination phase is covered, introducing chaining, error signaling, and bus exceptions. A description of the channel priority scheme rounds out the

section.

MREAD/WRITE OF THE DMAC REGISTERS BY MPU

The MPU reads and writes the DMAC internal registers and controls the DMA transfer.

Figure 12 indicates the timing diagram when the MPU reads the contents of the DMAC register. The MPU outputs $A_1\text{-}A_{23},\ FC_0\text{-}FC_2,\ \overline{AS},\ R/\overline{W},\ \overline{UDS},\ \text{and}\ \overline{LDS},\ \text{and}\ \text{accesses}$ the DMAC internal register. The specific internal register is selected by $A_1\text{-}A_7,\ \overline{LDS}$ and $\overline{UDS}.$ The \overline{CS} and \overline{IACK} lines are generated by the external circuit with $A_8\text{-}A_{23}$ and $FC_0\text{-}FC_2$. The DMAC outputs data on the data bus, together with $\overline{DDIR},\ \overline{DBEN}$ and \overline{DTACK} . The \overline{DDIR} and \overline{DBEN} control the bi-directional buffer on the bus and the \overline{DTACK} indicates that the data has been sent or received by the DMAC. Read Cycle is eighteen CLKs.

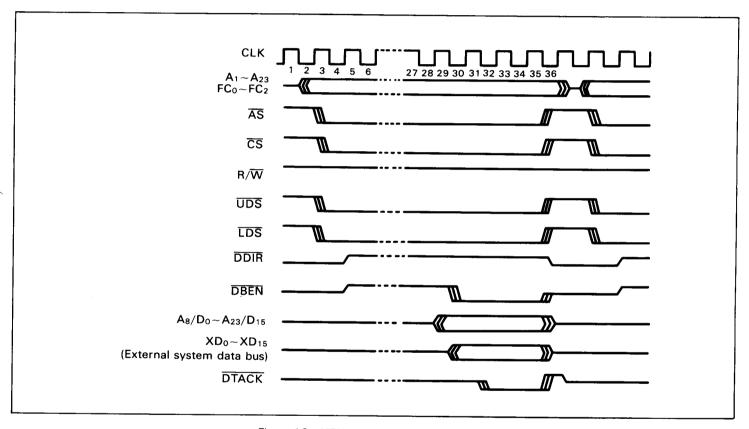


Figure 12 MPU Read from DMAC-Word

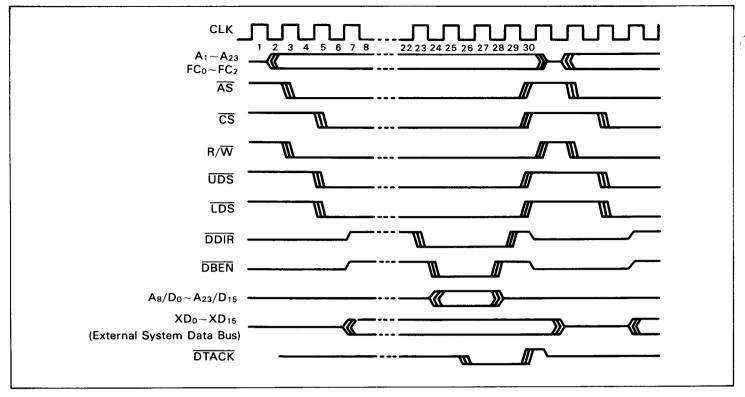


Figure 13 MPU Write to DMAC-Word

Figure 13 shows the MPU write cycle. Write cycle is fifteen CLKs.

Note the following points.

- (1) The clock reference shown in this figure is the DMAC input clock.
- (2) The DDIR and the DBEN are three-stated at the beginning which detects $\overline{\text{CS}}$ and the ending of the cycle.
- (3) During the MPU read cycle, the DTACK is asserted after the data is valid on the system bus.
- (4) During the MPU write cycle, the DDIR line will be driven low to direct the data buffers toward to DMAC before the buffers are enabled.

- (5) During the MPU write cycle, the DMAC will latch the data before asserting DTACK. Then it will negate DBEN and DDIR in the proper order.
- (6) After the MPU cycle and the \overline{LDS} and the \overline{UDS} are negated by the MPU, the DMAC will put \overline{DBEN}, \overline{DDIR} and the address data lines to a high impedance state.
- (7) DTACK will once go "High" and then to a high impedance state after negating LDS and UDS.

BUS ARBITRATION

The followings are the description of the bus arbitration. The DMAC must obtain the ownership of the bus in order to transfer data. Figure 14 indicates the DMAC bus arbitration timing. It is completely compatible with that of HD68000 MPU. The DMAC asserts the Bus Grant (\overline{BG}) to request the bus mastership. The

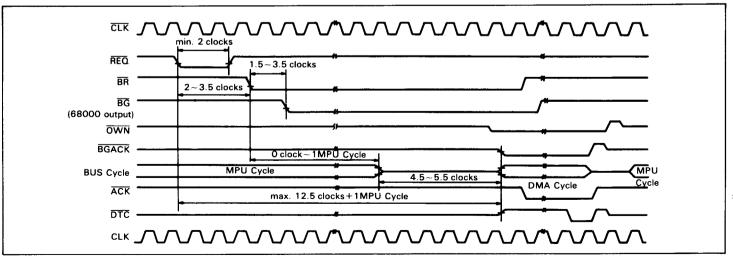


Figure 14 DMAC Bus Arbitration Timing



MPU recognizes the request and asserts \overline{BG} , then it grants the ownership in the next bus cycle. After the end of the current cycle (\overline{AS}) is negated, the MPU relinquishes the bus to the DMAC. The DMAC asserts the bus grant acknowledge (\overline{BGACK}) to indicate that it has the bus ownership. A half clock before \overline{BGACK} is asserted, the DMAC asserts \overline{OWN} . \overline{OWN} is kept asserted for a half clock after \overline{BGACK} is negated at the end of the DMA cycle. \overline{BR} is negated one clock after \overline{BGACK} is asserted.

■DEVICE/DMAC COMMUNICATION

Communication between peripheral devices and the \overline{DMAC} is accommodated by five signal lines. Each channel has \overline{REQ} , \overline{ACK} and \overline{PCL} , and the last two lines, the \overline{DONE} and \overline{DTC} lines, are shared among the four channels.

● Request (REQ)

The peripheral devices assert \overline{REQ} to request data transfers. See the "Requests" section for details.

Acknowledge (ACK)

This line is used to implicitly address the device which is transferring the data (This device is not selected by address lines). It is also asserted when the content of DAR is outputted during memory-to-memory transfer except for the auto-request mode at a limited rate or at the maximum rate.

● Peripheral Control Line (PCL)

The function of this line is quite flexible and is determined by the DCR (Device Control Register).

The DTYP bits of the DCR define what type of device is on the channel. If the DTYP bits are programmed to be a HMCS6800 device, the PCL difinition is ignord and the \overline{PCL} line is an Enable clock (E clock) input. If the DTYP bits are programmed to be a device with \overline{READY} , the PCL definition is ignored and the \overline{PCL} line is a ready input.

(1) PCL as a Status Input

The PCL line may be programmed as a status input. The status level of this line can be determined by the PCS bit in the CSR, regardless of the PCL function determined by the DCR. If a negative transition occurs and remains stable for a minimum of two clocks, the PCT bit of the CSR is set. This PCT bit is cleared by resetting the DMAC or writing "1" to the PCT bit.

(2) PCL as an Interrupt

The PCL line may be programmed to generate an interrupt on a negative transition. This enables an interrupt which is requested if the PCT bit of the CSR is set. When using this function, it is necessary to reset the PCT bit in the CSR before the PCL bit in the DCR is set to interrupt, in order to avoid assertion of IRQ line at this time.

(3) PCL as a 1/8 Starting Pulse

The PCL line may be programmed to output a 1/8 starting pulse. This active low starting pulse is outputted when a channel is activated, and is "Low" for a period of four clock cycles.

(4) PCL as an Abort Input

The PCL line may be programmed to be a negative transition abort input which terminates an operation by setting the external abort error in CER. It is necessary to reset the PCT bit in the CSR before activating the channel (Setting the ACT bit of CCR) so that the channel operation is not immediately aborted.

(5) PCL as an Enable Clock (E Clock) Input

If the DTYP bits are programmed to be a HMCS6800 device, the PCL definition is ignored and the \overline{PCL} line is an Enable Clock input. The Enable clock downtime must be as long as five clock cycles, and must be high for a minimum of three DMAC clock

cycles, but need not be synchronous with the DMAC's clock.

(6) PCL as a READY Input

If the DTYP bits are programmed to be a device with \overline{READY} , the PCL definition is ignored and the \overline{PCL} line is a \overline{READY} input. The \overline{READY} is an active low input.

DONE (DONE)

This line is an active low Input/Output signal with an open drain. It is asserted when the memory transfer count is exhausted in a single block transfer. In the chaining operation, \overline{DONE} is asserted only at the last transfer to the peripheral device of the last data block. In the continue mode, \overline{DONE} is asserted for each data block. It is asserted and negated in coincident with the \overline{ACK} line for the last data transfer to the peripheral device. It is also outputted in coincident with the \overline{ACK} line of the last bus cycle, in which the address is outputted from the DAR, in the memory-to-memory transfer (dual addressing mode) that uses the \overline{ACK} line.

The DMAC also monitors the state of the \overline{DONE} line during the DMA bus cycle. If the device asserts \overline{DONE} during \overline{ACK} active, the DMAC will terminate the operation after the transfer of the current operand. If \overline{DONE} is asserted on the first byte of 2-byte operation or the first word of long word operation, the DMAC does not terminate the operation before the whole operand transfer is completed. If \overline{DONE} is asserted, then the DMAC terminates the operation by clearing the ACT bit of the CSR, and setting the COC and NDT bits of the CSR. If both the DMAC and the device assert \overline{DONE} , the device termination is not recognized, but the channel operation does terminate. \overline{DONE} is outputted again for the retry exceptions bus cycles.

The case that the multi-block transfer with \overline{DONE} mode is set is described later.

● Data Transfer Complete (DTC)

DTC is an active low signal which is asserted when the actual data transfer is accomplished. It is also asserted in the bus cycle which read a chain information from memory in the Chaining mode. However, if exceptions are generated and the DMA bus cycle terminates, DTC is not asserted. DTC is asserted one half clock before LDS and UDS are negated, and negated one half clock after LDS and UDS are negated.

EREQUESTS

Requests may be externally generated by circuitry in the peripheral device, or internally generated by the auto-request mechanism. The REQG bits of the OCR determine these modes. The DMAC also supports an operation in which the DMAC auto-requests the first transfer and then waits for the peripheral device to request the following transfers.

Auto-request Transfers

The auto-request mechanism provides generation of requests within the DMAC. These requests can be generated at either of two rates: maximum-rate and limited-rate. In the former case, the channel always has a request pending.

The limited rate auto-request functions by monitoring the bus utilization.

(1) Limited-rate Auto-request

1,		TIM	E→		
1 1	Previous nple Interval	Current Sample Interval		Next Sample Interval	
		LRAR Interval			



In the limited-rate auto-request, the DMAC devides time into equal length sample intervals by counting clock cycles. The end of one sample interval makes the beginning of the next. During a sample interval, the DMAC monitors, by means of BGACK pin, the system bus activity of the DMAC and other bus master devices. At the end of the sample interval, decision is made whether or not to perform the channel's data transfer during the next sample interval. Namely, based on the activity of the DMAC or other bus master devices during the current sample interval, the DMAC allows limited-rate auto-requests for some initial portion of the next sample interval.

The length of the sample interval, and the length of the limited-rate auto-request generation period (the limited-rate auto-request interval) are controlled by the BT and BR bits in the GCR. The length in clock cycles of the limited-rate auto-request interval is $2^{(BT+4)}$ (2 raised to the BT+4 power). For example, if BT equals 2 and the DMA utilization of the bus was low during the previous sample interval, then the DMAC generates the auto-request transfers during the first 64 clock cycles.

The ratio of the length of the sample interval to the length of the limited-rate auto-request interval is controlled by the BR bits. The ratio of the system bus utilization of the MPU to other bus master devices including the DMAC is $2^{(BR+1)}$ (2 raised to the BR +1 power). If the fraction of DMA clock cycles during the sample interval exceeds the programmed utilization level, the DMAC will not allow limited-rate auto-requests during the next sample interval.

For example, if BR equals 3, then at most one out of 16 clock cycles during a sample interval can be used by the DMAC and other bus master devices, and still the DMAC would allow

limited rate auto-request during the next sample interval. Therefore, from the viewpoint of long period, the ratio of the system bus utilization of the MPU to I/O devices including the DMAC is about 16: 1. The sample interval length is not a direct parameter, but it is equal to 2^(BT+BR+5) clock cycles. Thus, the sample interval can be programmed between 32 and 2048 clock cycles.

The DMAC uses the \overline{BGACK} to differentiate between the MPU bus cycle and DMAC or other bus master devices. If \overline{BGACK} is active, then the DMAC assumes that the bus is used by a DMAC or other bus master devices. If it is inactive, then the DMAC assumes that it is used by the MPU.

(2) Maximum-rate Auto-request

If the REQG bits in the OCR indicate auto-request at the maximum rate, the DMAC acquires the bus after the start bit is set and keeps it until the data transfer is completed.

If a request is made by another channel of higher priority, the DMAC services that channel and then resumes the auto-request sequence. If two or more channels are set to equal priority level and maximum rate auto-request, then the channels will rotate in a "round robbin" fashion.

If the HMCS68000 compatible device is connected to a channel, the \overline{ACK} line is held inactive during an auto-request operation. Consequently, any channel may be used for the memory-to-memory transfer with the auto-request function in addition to the operation of data transfer between memory and peripheral device with using the \overline{REQ} pin. Refer to Figure 15 for the timing of the memory-to-memory transfer. In this mode, the \overline{ACK} , \overline{HIBYTE} and \overline{DONE} outputs are always inactive.

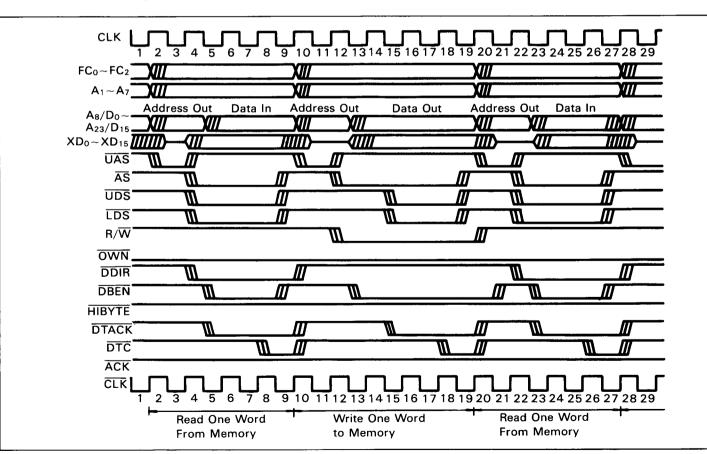


Figure 15 Memory-to-Memory Transfer Read-Write-Read Cycles



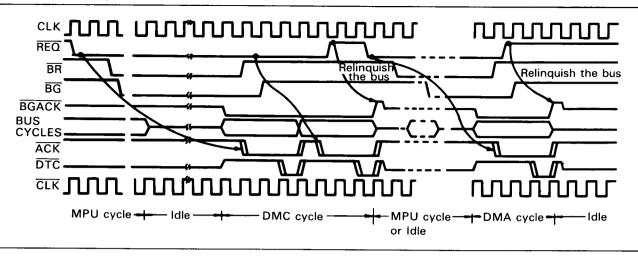


Figure 16 Burst Mode Request Timing (Only one channel is active)

External Requests

If the REQG bits of the OCR indicate that the REQ line generates requests, the transfer requests are generated externally. The request line associated with each channel allows the device to externally generate requests for DMA transfers. When the device wants an operand transferred, it makes a request by asserting the request line. The external request mode is determined by the XRM bits of the DCR, which allows both burst and cycle steal request modes. The burst request mode allows a channel to request the transfer of multiple operands using consecutive bus cycles. The cycle steal request mode allows a channel to request the transfer of a single operand. The followings are the description of the burst and the cycle steal modes.

(1) Burst Request Recognition

In the burst request mode, the \overline{REQ} line is an active low input. The level sampled at the rising edge of the clock. Once the burst request is asserted, it needs to be held low until the first DMA bus cycle starts in order to insure at least one data transfer operation. In order to stop the burst mode transfer after the current bus cycle, the \overline{REQ} line has to be negated one clock before the \overline{DTC} output clock of this cycle. Refer to Figure 16 or the burst mode timing.

(2) Cycle Steal Request Recognition

In the cycle steal request mode, the peripheral device requests the

DMA transfer by generating an falling edge at the \overline{REQ} line. The \overline{REQ} line needs to be held "low" for at least 2 clock cycles. In the cycle steal mode, if the \overline{REQ} line changes from "High" to "Low" between \overline{ACK} output and one clock before the clock that outputs \overline{DTC} , then the next DMA transfer is performed without relinquishing the bus. If the bus is not relinquished, then maximum of 5 idle clocks is inserted between bus cycles.

Refer to Figure 17 for the request timing of the cycle steal mode. If the XRM bits specify cycle steal without hold, the DMAC will relinquish the bus. If the XRM bits specify cycle steal with hold, the DMAC will hold the bus and wait for the next \overline{REQ} input for at least 1 sample interval after the current bus cycle completion. The allowable hold time is up to 2 sample intervals.

Figure 18 shows the request timing in the cycle steal bus hold. If the \overline{REQ} is inputted during the hold time, the \overline{ACK} is outputted after a maximum of 7.5 clock cycles from the picked-up clock.On the cycle steal with hold mode, the DMAC will hold the bus even when the transfer count is exhausted and the last data has been transferred. If DMA transfer is requested from other channel during this period, they are executed normally.

(3) Request Recognition in Dual-address Transfers

In a following section, dual-address transfers are defined. Dual address transfer is an exception to the request recognition rules

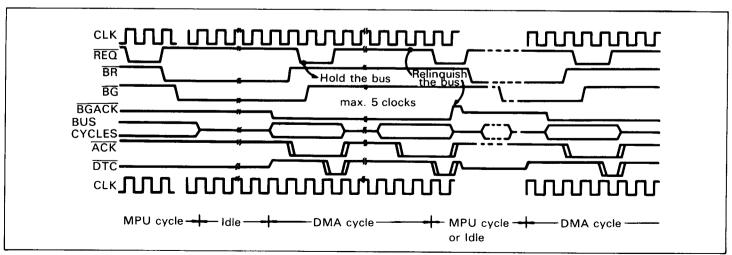


Figure 17 Cycle Steal Mode Request Timing



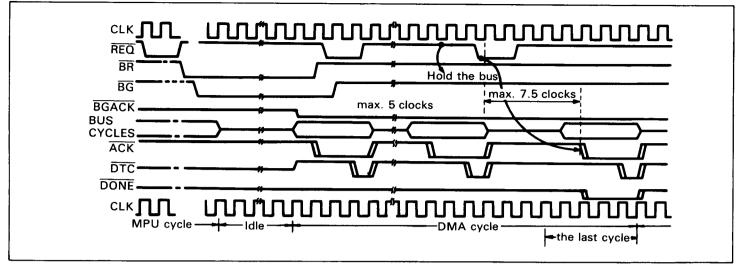


Figure 18 Cycle Steal Bus Hold Mode Request Timing

in the previous paragraphs. In the cycle steal request mode, when there are two or more transfers between the DMAC and the peripheral device during one operand transfer, the request is not recognized until the last transfer between the DMAC and the I/O device starts.

Mixed Request Generation

A single channel can mix two request generation methods. By programming the REQG bits of the OCR to "11", when the channel is started, the DMAC auto-requests the first transfer. Subsequent requests are then generated externally by the device. The \overline{ACK} and \overline{PCL} lines perform their normal functions in this operation.

DATA TRANSFERS

All DMAC data transfers are assumed to be between memory and the peripheral device. The word "memory" means a 16-bit HD68000 bus compatible device. By programming the DCR, the characteristics of the peripheral device may be assigned. Each channel can communicate using any of the following protocols.

DTYP	Device 1 ype	
00	HD68000 compatible device	Dual Addressing
01	HD6800 compatible device	Dual Addressing
10	Device with ACK	Cinala Addussaina
11	Device with ACK and READY	Single Addressing

Dual Addressing

HD68000 and HD6800 compatible devices may be explicity addressed. This means that before the peripheral transfers data,

a data register within the device must be addressed. Because the address bus is used to address the peripheral, the data cannot be directly transferred to/from the memory because the memory also requires addressing. Instead, the data is transferred from the source to the DMAC and held in an internal DMAC holding register. A second bus transfer between the DMAC and the destination is then required to complete the operation. Because both the source and destination of the transfer are explicitey addressed, this protocol is called dual addressing.

(1) HD68000 Compatible Device Transfers

In this operation, when a request is received, the bus is obtained and the transfer is completed using the protocol as shown in Figures 19 and 20. Figures 21 through 24 show the transfer timings. Figures 21 and 24 show the operation when the memory is the source and the peripheral device is the destination. Figures 22 and 23 show the transfer in the opposite direction. The peripheral device is a 16-bit device in Figures 21 and 22, and a 8-bit device in Figures 23 and 24.

(2) HD6800 Compatible Device Transfers

When a channel is programmed to perform HD6800 compatible transfers, the \overline{PCL} line for that channel is defined as an Enable clock input. The DMAC performs data transfers between itself and the peripheral device using the HD6800 bus protocol, with the \overline{ACK} output providing the \overline{VMA} (valid memory address) signal. Figure 25 illustrates this protocol. Refer to Figure 26 for the read cycle timing and Figure 27 for the write cycle timing. In Figure 26, the DMAC latches the data at the falling edge of clock 19, so a latch to hold the data is necessary as shown in the figure.

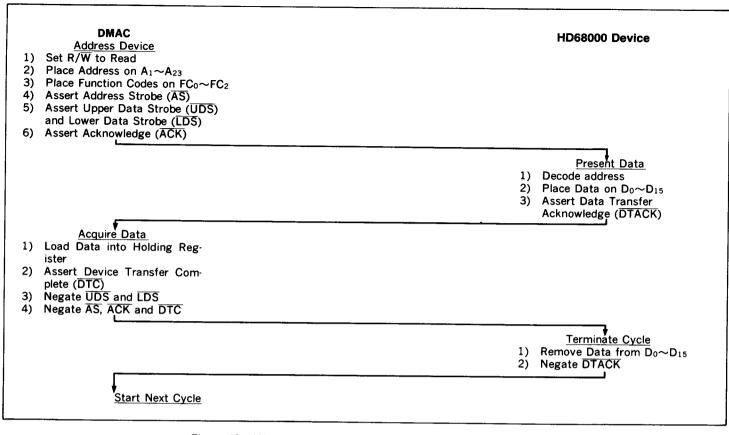


Figure 19 Word Read Cycle Flowchart HD68000 Type Device

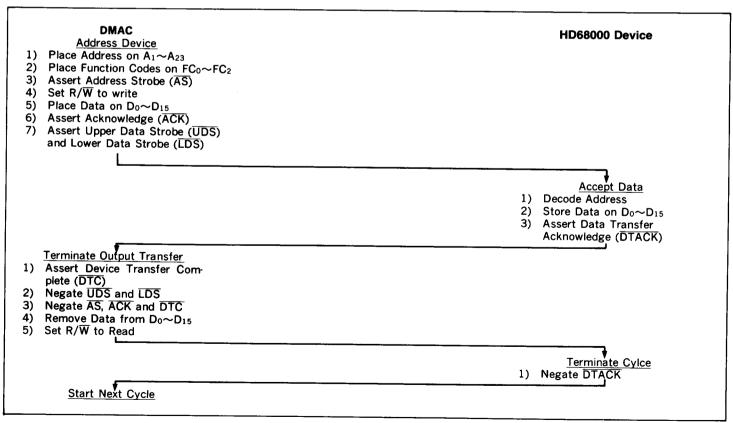


Figure 20 Word Write Cycle Flowchart HD68000 Type Device



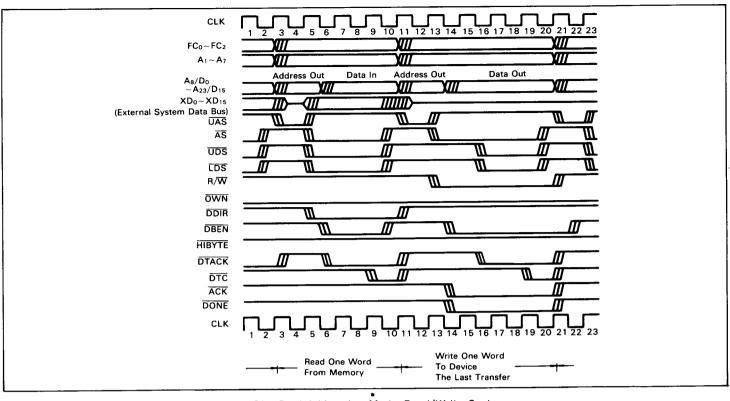


Figure 21 Dual Addressing Mode, Read/Write Cycle, Destination=16-bit Device, Word Operand

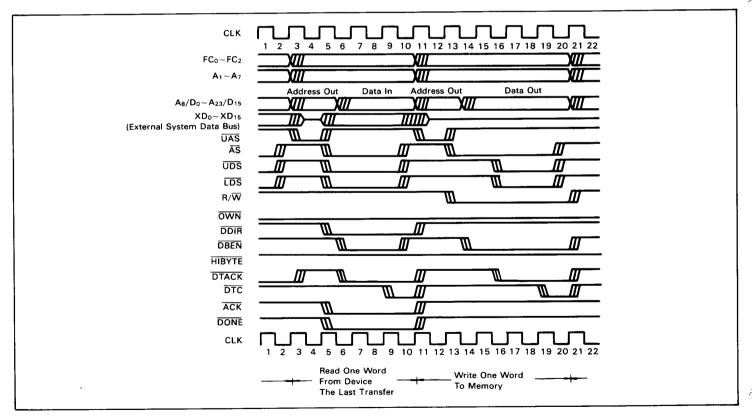


Figure 22 Dual Addressing Mode, Read/Write Cycle, Source=16-bit Device, Word Operand



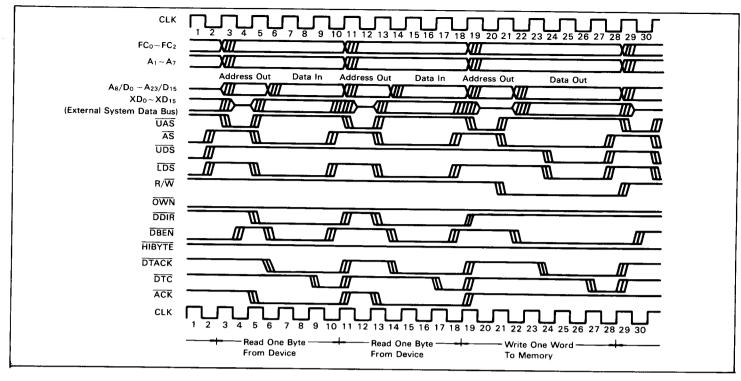


Figure 23 Dual Addressing Mode, Read/Write Cycle, Source=8-bit Device, Word Operand

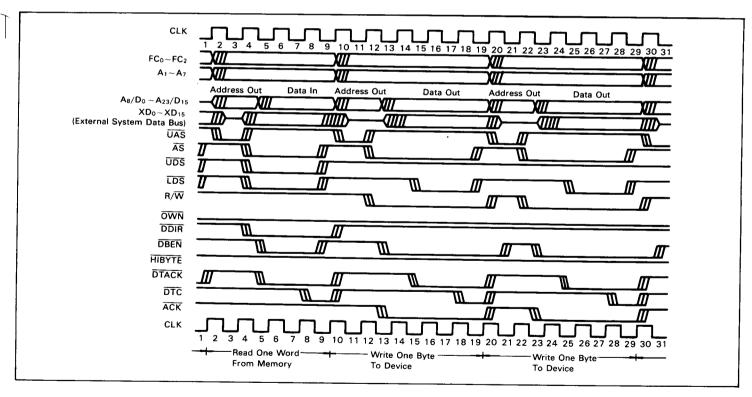


Figure 24 Dual Addressing Mode, Read/Write Cycle, Destination=8-bit Device, Word Operand



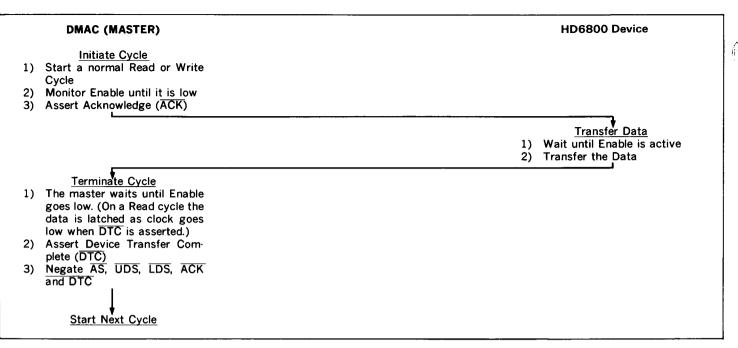


Figure 25 HD6800 Cycle Flowchart

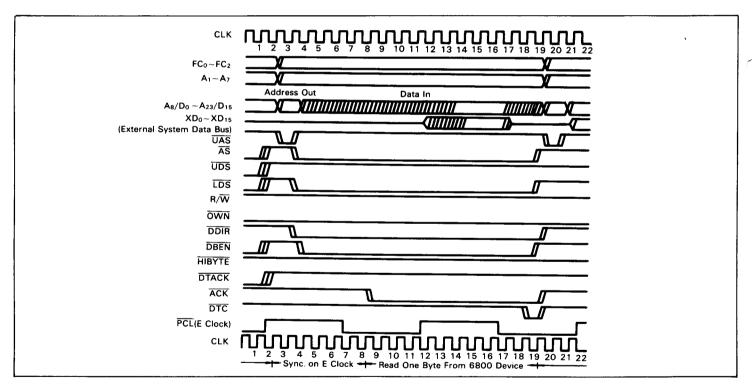


Figure 26 Dual Addressing Mode, HD6800 Compatible Device, Read Cycle

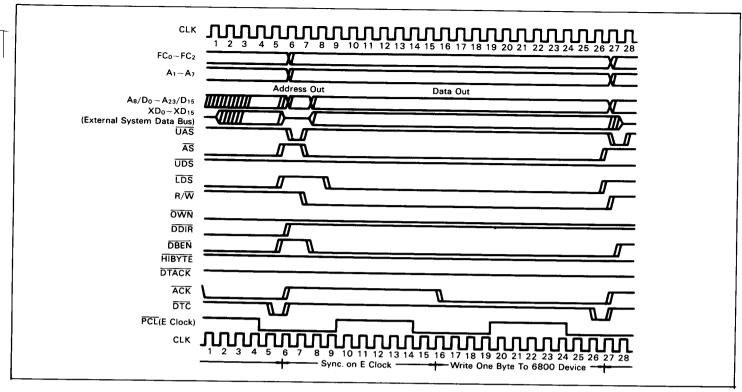


Figure 27 Dual Addressing Mode, HD6800 Compatible Device, Write Cycle

(3) An Example of a Dual Address Transfer

This scetion contains an example of a dual address transfer using Table 2 of Dual-Address Sequencing. The transfer mode of this example is the following.

- 1. Device Port size=8 bits
- 2. Operand size=Long Word (32 bits)
- 3. Memory to Device Transfer
- 4. Source (Memory) Counts up, Destination (Device) Counts Down

In this mode, a data transfer from the source (memory) is done according to the 6th row of Table 2, since the port size of the memory is always 16 bits. A data transfer to the destination

(device) is done according to the 3rd row of Table 2. Table 3 shows the data transfer sequence.

The port size in Table 2 is not related to the DPS bit of the DCR. The DPS defines the port size of the device only. The DPS is set to "0" in this example as the device port size is 8 bits.

The memory map of this example is shown in Table 4. The operand consists of BYTE A through BYTE D in memory of Table 4. Prior to the transfer, MAR and DAR are set to 00000012 and 00000108 respectively. The operand is transferred to the 8-bit port device according to the order of transfer number in Table 3.

Table 2	Dual-Address	Sequencing
---------	--------------	------------

Row No. Port Size	Port Size	Operand Size	Operand Part Size	Operand Part Addresses	Address Increment		
				oporana i are Addresses	+	=	_
1	8	BYTE	BYTE	Α	+2	0	-2
2	8	WORD	BYTE	A, A+2	+4	0	-4
3	8	LONG	BYTE A, A+2, A+4, A+6 *4 *3 *5 *7 *8 PACK (BYTE or WORD)** A		+8	0	-8 *1
4	16	BYTE			+P	0	P
5	16	WORD	WORD	Α	+2	0	-2
6	16	LONG	WORD *2	A, A+2 *1 *6	+4	0	-4

^{*}Numbers in Table 2 correspond to ones in Tables 3 and 4.

^{* *}Refer to Address Sequencing on Operand Part Size and PACK.



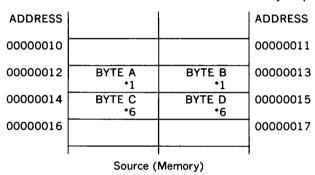
Table 3 An Example of a Data Transfer for One Operand

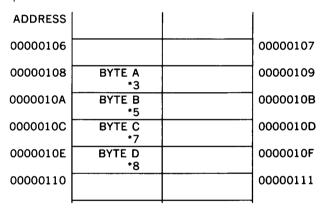
SRC: Source (Memory), DST Destination (Device), HR: Holding Register (DMAC Internal Reg.)

Transfer No. Data Transfer	Data Tuamafau	Address	Data Size	DMAC Registers after Transfer		Comment	
	Data Transfer	Output		MAR	DAR	Comment	
0	_	_		00000012	00000108	Initial Register Setting	
1	SRC→HR	00000012 *1	WORD *2	00000014	00000108	Higher order 16 bits of operand is fetched.	
2	HR →DST	00000108 *3	BYTE *4	00000014	0000010A	Higher order 16 bits of operand is	
3	HR →DST	0000010A *5	BYTE *4	00000014	0000010C *10	transferred.	
4	SRC→HR	00000014 *6	WORD *2	00000016 *9	0000010C	Lower order 16 bits of operand is fetched.	
5	HR →DST	0000010C *7	BYTE *4	00000016	0000010E	Lower order 16 bits of operand is	
6	HR →DST	0000010E *8	BYTE *4	00000016	00000110 *10	transferred.	
6′		_	_	00000016	00000110	MAR, DAR are pointing the next operand addresses when the transfer is complete.	

Mode: Port size=8, operand size=Long Word, Memory to Device, Source (Memory) Counts Up, Destination (Device) Counts Down

Table 4 Memory Map for the Example of the Data Transfer





Destination (Device)

Single Addressing Mode

Implicitly addressed devices are peripheral devices selected not by address but by \overline{ACK} . They do not require addressing of data register during data transfer. Transfers between memory and these devices are controlled by the request/acknowledge protocol. Such peripherals require only one bus cycle to transfer data, and the DMAC internal holding register is not used. Because only the memory is addressed during a data transfer and a transfer is done in only one bus cycle, this protocol is called single-addressing.

(1) Device with ACK Transfers

Under this protocol, the communication between peripheral device and the DMAC is performed with a two signal $\overline{REQ/ACK}$ handshake. When a request is generated using the request method programmed in the DMAC's internal control registers, the DMAC obtains the bus and responds with \overline{ACK} . The DMAC asserts all the bus control signals required for the memory access. Refer to Figure 28 for the flowchart of the data transfer from memory to the device with \overline{ACK} . Figure 29 shows the flowchart of the data transfer from the device with \overline{ACK} to memory. Receiving the transfer request, the DMAC obtains the bus. Then the DMAC outputs the memory address and asserts

 \overline{ACK} to inform the I/O device that the transfer request has been acknowledged. When the DMAC accepts \overline{DTACK} from memory, it asserts \overline{DTC} and informs the peripheral device of the transfer termination.

Figures 30 and 31 show the transfer timings of the device with \overline{ACK} : the port size for the former figure is 8-bit and the latter is 16-bit respectively.

When the transfer is from memory to a device, data is valid when \overline{DTACK} is asserted and remains valid until the data strobes are negated. The assertion of \overline{DTC} from the DMAC may be used to latch the data as data strobes are not negated half clock period after the assertion of \overline{DTC} .

When the transfer is from device to memory, data must be valid on the HD68000 bus before the DMAC asserts the data strobes. The data strobes are asserted one clock period after \overline{ACK} is asserted. When the DMAC obtains the bus and starts a DMA cycle, the three-state of the \overline{OWN} line is cancelled a half clock earlier than other control lines. If the DMA Cycle terminates and the DMAC relinquishes the bus, all the control signals get three-stated a half clock before \overline{OWN} . The \overline{DDIR} and

OHITACHI

DBEN lines are not asserted in the single addressing mode. Four-clock cycle is the smallest bus cycle for the transfer from memory to device. Five-clock cycle is the smallest bus cycle for the transfer from device to memory. If the device port size is 8bits, either LDS or UDS is asserted. In the single addressing

mode, $A_8/D_0 \sim A_{23}/D_{15}$ are outputted for only one and a half clock from the beginning of the DMA bus cycle. Therefore, A_8/D_0 through A_{23}/D_{15} need to be latched externally just like in the dual addressing mode.

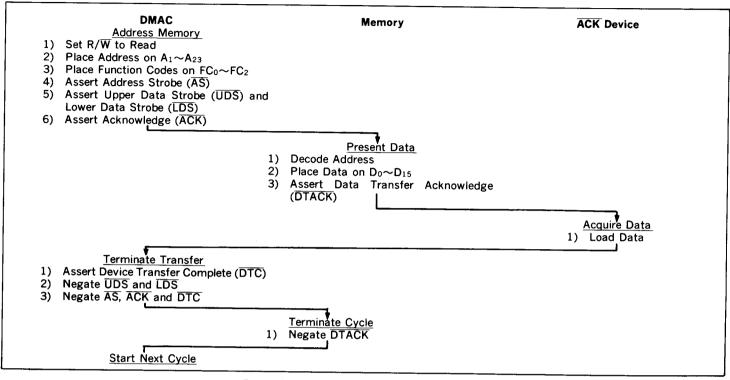


Figure 28 Word from Memory to Device with ACK

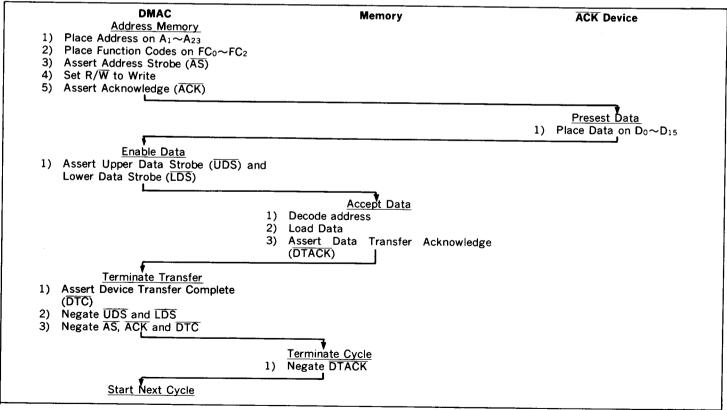


Figure 29 Word from Device with ACK to Memory



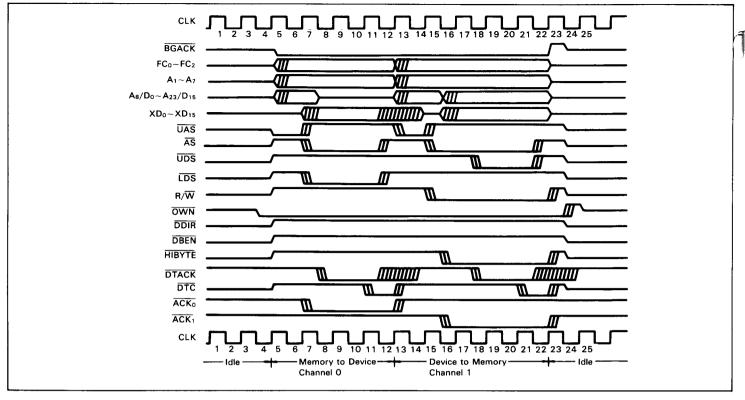


Figure 30 Single Addressing Mode with 8-Bit Devices as Source and Destination (Read-Write Cycles)

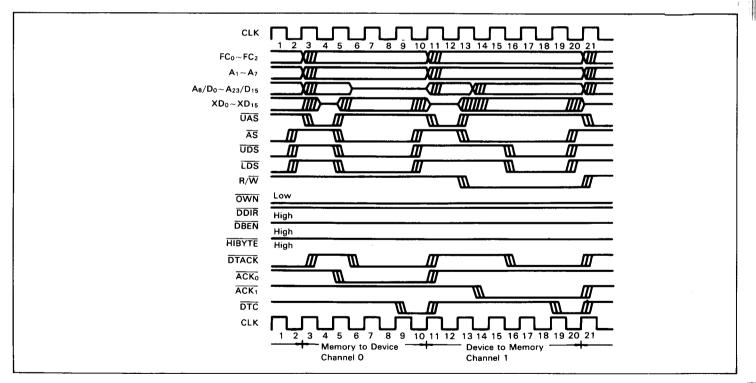


Figure 31 Single Addressing Mode with 16-bit Devices as Source and Destination (Read-Write Cycles)



(2) Device with ACK and READY Transfers

Under this protocol, the communication between peripheral device and the DMAC is performed using a three signal $\overline{REQ}/\overline{ACK/READY}$ handshake. The \overline{READY} input to the DMAC is provided by the \overline{PCL} line. The \overline{READY} line is active low. When a request is generated using the request method programmed in the control registers, the DMAC obtains the bus and asserts \overline{ACK} to notify the device that the transfer is to take place. The DMAC waits for \overline{READY} (\overline{PCL} input), which is a response from the device, in addition to \overline{DTACK} which is a response from memory.

When the DMAC accepts both signals, it terminates the transfer. Refer to Figures 34 and 35 for the flowcharts of the data transfer between memory and the device with \overline{ACK} and \overline{READY} . Refer to Figure 36 for the transfer timing of the 8-bit device. When the data transfer is from memory to a device, data is valid from the assertion of \overline{DTACK} to the negation of \overline{LDS} and \overline{UDS} . \overline{DTC} is asserted a half clock before \overline{LDS} and \overline{UDS} are negated, so this line may be used for latching the data by the peripheral device. In this case, \overline{READY} (\overline{PCL} input) indicates that the device has received the data. Both \overline{DTACK} and \overline{READY} (\overline{PCL} input) signals are needed for terminating the DMA cycle.

When the data transfer is from the device to memory, data must be valid on the bus before the DMAC asserts LDS and UDS.

Therefore, \overline{READY} (\overline{PCL} input) is used as the signal to indicate that the peripheral device has outputted the data on the bus. When the DMAC detects PCL (READY input), then it asserts \overline{LDS} and \overline{UDS} . After asserting \overline{LDS} and \overline{UDS} , the DMAC terminates the cycle when \overline{DTACK} signal from the memory is detected.

As mentioned above, the I/O device and the DMAC communicate each other through three handshake signals in Figure 32.

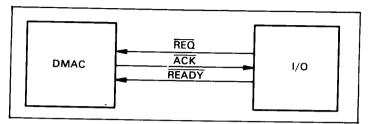


Figure 32 Device with ACK and READY, and DMAC transfer protocol

Figure 33 shows the timing of transfers between the memory and the device with \overline{ACK} and \overline{READY} . The detail is as Follows.

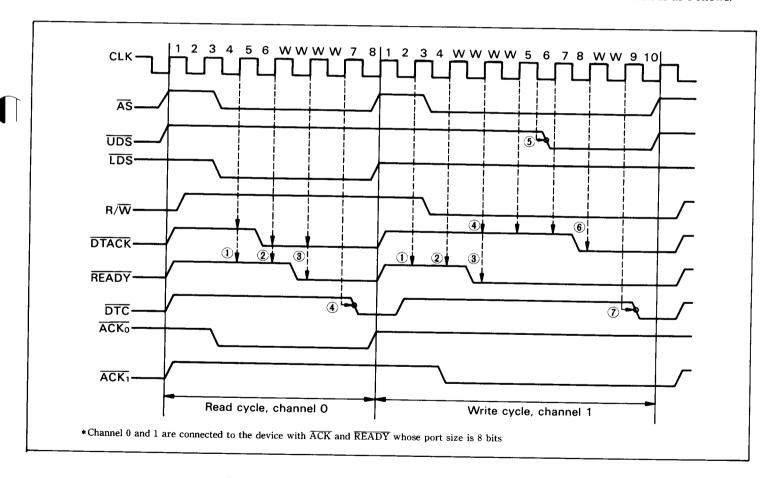


Figure 33 Device with ACK and READY Mode Timing



(i) Data transfer from the memory to the I/O device (read cycle)

The DMAC samples both \overline{DTACK} and \overline{READY} signals at the rising edge of CLK 5 (Figure 33 ①).

Until both signals are asserted, the DMAC repeats wait cycles and samples those signals at each rising edge of the clock: the DMAC does not proceed to CLK 7 and 8 (Figure 33 ②).

When both \overline{DTACK} and \overline{READY} signals are asserted (Figure 33 ③), the DMAC proceeds to CLK 7 and 8, asserts \overline{DTC} at the rising edge of CLK 7 (Figure 33 ④), and terminates the bus cycle. The bus cycle is 4-clock long when there is no wait cycles.

(ii) Data transfer from the I/O device to the memory (write cycle)

The DMAC samples \overline{READY} signal at the rising edge of CLK 3 (Figure 33 ①). Until \overline{READY} signal is asserted, the DMAC repeats wait cycles and samples the signal at each rising edge of the clock: the DMAC does not proceed to CLK 5 and 6 (Figure 33 ②).

When \overline{READY} signal is asserted (Figure 33 ③), the DMAC proceeds to CLK $5\sim8$, and asserts \overline{DS} at the falling edge of CLK 5 (Figure 33 ⑤).

Table 5 indicates the combinations of port size and operand size of the peripheral devices supported by the DMAC in the single and dual addressing modes. In the single addressing mode, port size and operand size must be the same. In the dual addressing mode, byte operand cannot be used when the port size is sixteen and the REQG bit is 10 or 11.

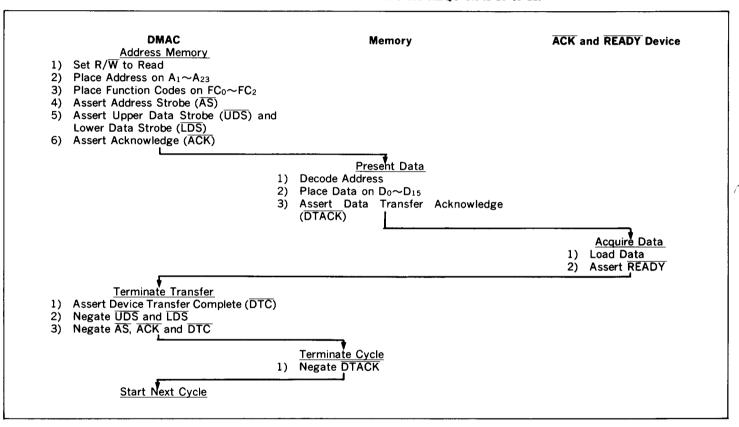


Figure 34 Word from Memory to Device with ACK and READY

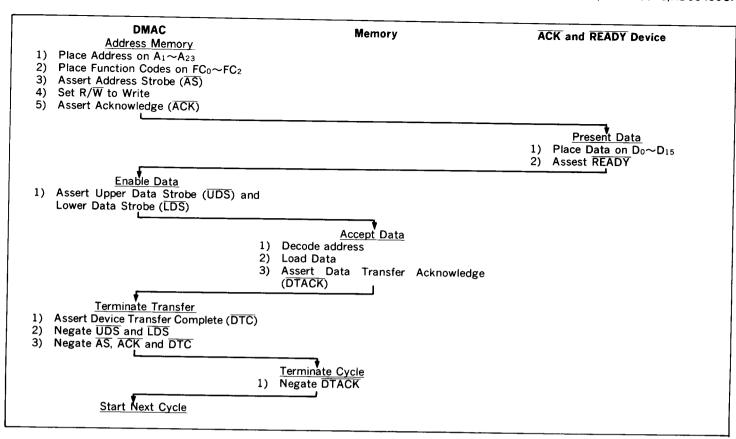


Figure 35 Word from Device with ACK and READY to Memory

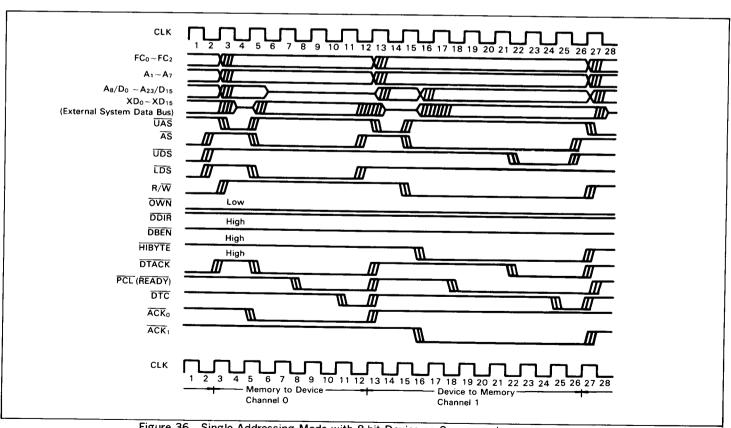


Figure 36 Single Addressing Mode with 8-bit Device as Source and Destination with PCL Used as a READY input (Read-Write Cycles)



Table 5 Operation Combinations

Addressing	Douise Tune	Port	Operand			DEOC 1:14 OOD	
Addressing	Device Type		Byte	Word	Long Word	REQG bits of OCR	
Dual	68000, 6800	8	0	0	0	00, 01, 10, 11	
Dual	68000, 6800	16	0	0	0	00, 01	
Dual	68000, 6800	16	×	0	0	10, 11	
Single	with ACK or ACK & READY	8 16	O ×	×	×	00, 01, 10, 11 00, 01, 10, 11	

O: supported

× : not supported

REOG

00: Auto request at a limited rate Auto request at a maximum rate

10:

REQ line requests the operand transfer

11:

First operand is auto requested, and subsequent operands

are externally requested.

Address Sequencing

The sequence of addresses generated depends upon the port size, whether the addresses are to count up, down or not change and whether the transfer is executed in the single addressing mode or the dual addressing mode. The memory address count method and the peripheral device address count method is programmed using the Memory address count (MAC) bit and the Device address count (DAC) bit in the Sequence Control Register (SCR).

Single addressing mode

In the single addressing mode, memory address sequencing is shown in Table 6. If the operand size is byte, the memory address increment is one (1). If the operand size is word, the memory address increment is two (2). If the memory address register does not count, the memory address is unchanged after the transfer.

(ii) Dual addressing mode

In the dual addressing mode, the operand size need not match the port size. Thus the transfer of an operand may require several DMA bus cycles. Each DMA bus cycle, between memory and DMAC and between DMAC and the device, is called the operand part and transfers a portion or all of the operand. The addresses of the operand parts are in a linear increasing sequence. The step between the addresses of the operand is two. The size of the operand part is the minimum of the port size and the operand size. The number of the operand part is the operand size divided by the port size.

In the dual addressing mode, memory is regarded as a device whose port size is 16 bits and the operand size is a byte or a word. When the operand is transferred to the memory from the I/O device whose port size is 8 bits and the operand size is byte, the DMAC reads 2-byte operand one byte at a time from the I/O device and writes 2 bytes at the same time to the memory, or reads one byte from the I/O device and writes one byte to the memory. Thus, when the port size is 8 bits and the operand size is byte. two-operand transfer which is performed at the same time is called PACK. Utilizing the PACK, the DMAC may improve the DMA bus efficiency. However, packing is not performed if the address does not count. When the port size is 8 bits and the operand size is byte (port size: 8 bits. without PACK) with the DMAC in the dual addressing mode, the DMAC repeats the following cycles:

- ① READ BYTE (reads data from the I/O device or the memory)
- ② WRITE BYTE (writes data to the I/O device or the memory)

Table 7 shows the dual addressing sequencing

Table 6 Single Address Sequencing

Port Size	Operand Size	Memory Address Increment					
FOR SIZE	Operatio Size	+(increment)	=(unchanged)	-(decrement)			
8	Byte	+1	0	- 1			
16	Word	+2	0	-2			

Table 7 Dual Address Sequencing

Port Size	Operand Size	Part Size	Operand Part	Address Increment		
			Address	+	=	_
8	Byte	Byte	Α	+2	0	-2
8	Word	Byte	A, A+2	+4	0	-4
8	Long	Byte	A, A+2, A+4, A+6	+8	0	-8
16	Byte	Pack	A	+P	0	-Р
16	Word	Word	A	+2	0	-2
16	Long	Word	A, A+2	+4	0	-4

P=1 if packing is not done

=2 if packing is done

Pack = byte if packing is not done

=word if packing is done



■INITIATION AND CONTROL OF CHANNEL OPERATION

Operation Initiation

To initiate the operation of a channel, the STR bit of the CCR is set to start the operation. Setting the STR bit causes the immediate activation of the channel, the channel will be ready to accept requests immediately. The channel initiates the operation by resetting the STR bit and setting the channel active bit in the CSR. Any pending requests are cleared, and the channel is then ready to receive requests for the new operation. If the channel is configured for an illegal operation, the configuration error is signaled, and no channel operation is run. The illegal operations include the selection of any of the options marked "(undefined, reserved)". If the MTC is set to zero in any mode other than the chaining mode, or BTC is set to zero in the array chaining mode, then the count error is signaled and the channel is not activated. The channel cannot be started if any of the ACT, COC, BTC, NDT or ERR bit is set in the CSR. In this case, the channel signals the operation timing error.

Operation Continuation (Continue Mode)

When the STR bit or the ACT bit in the CSR is set, setting the CNT (Continue) bit in the CCR allows multiple blocks to be transferred as in the chaining modes. The CNT bit is set in order to continue the current channel operation. To set the CNT bit, the initial address of the next block to be transferred, the corresponding function code, and the number of words to be transferred must be previously set to the BAR, BFC and BTC. If the CNT bit is set when either the STR or the ACT bit is not set, the operation timing error is signaled. The configuration error is signaled when the CNT bit is set in the chaining modes.

Operation Halting (Halt)

The CCR has a halt bit which allows suspension of the operation of the channel. If this bit is set, a request may still be generated and recognized, but the DMAC does not attempt to acquire the bus or to make transfers for the halted channel. When this bit is reset, the channel resumes operation and services any request that may have been received while the channel was halted. However, in the burst request mode, the transfer request should be kept asserted until the initiation of the first transfer after clearing the halt bit.

● Operation Abort by Software (Software Abort)

Setting the software abort bit (SAB) in the CCR allows the current operation of the channel to be aborted. In this case, the ERR bit and the COC bit in the CSR are set and the ACT bit is reset. The error code for the software abort is set in the CER. The SAB bit is designed to be reset if the ERR bit is reset. When the CCR is read, the SAB always reads as zero(0).

ECHANNEL OPERATION TERMINATION

As part of the transfer of an operand, the DMAC decrements the memory transfer counter(MTC). If the chaining mode is not used and the CNT bit is not set or the last block is transferred in the chaining mode, the operation of the channel is complete when the last operand transfer is completed and the MTC is zero. The DMAC notifies the peripheral device of the channel completion via the \overline{DONE} output.

However, in the continue mode, \overline{DONE} is outputted at the termination of every data block transfer. When the channel operation has been completed, the ACT bit of the CSR is cleared, and the COC bit of the CSR is set.

The occurrence of errors, such as the bus error, during the DMA bus cycle also terminates the channel operation. In this case, the ACT bit in the CSR is cleared, the ERR and the COC bits are set, and at the same time the code corresponding to the error that occurred is set in the CER.

Channel Status Register (CSR)

The channel status register contains the status of the channel at the channel operation termination. The register is cleared by writing a one (1) into each bit of the register to be cleared.

COC

The channel operation complete (COC) bit is set if the channel operation has completed. The COC bit must be cleared in order to start another channel operation. The COC bit is cleared only by writing a one to this bit or resetting the DMAC.

PCS

The peripheral status (PCS) bit reflects the level of the \overline{PCL} line regardless of its programmed function. If \overline{PCL} is at "High" level, the PCS bit reads as one. If \overline{PCL} is at "Low" level, the PCS bit reads as zero. The PCS bit is unaffected by writing to the CSR.

PCT

The peripheral control transition (PCT) bit is set, if a falling edge transition has occurred on the \overline{PCL} line. (The \overline{PCL} line must remain at "low" level for at least two clock cycles.) The PCT bit is cleared by writing a one to this bit or resetting the DMAC.

BTC

Block transfer complete (BTC) bit is set when the continue (CNT) bit of CCR is set and the memory transfer counter (MTC) is exhausted. The BTC bit must be cleared before the another continuation is attempted (namely, setting the CNT bit again), otherwise an operation timing error occurs. The BTC bit is cleared by writing a one to this bit or resetting the DMAC.

NDT

Normal device termination (NDT) bit is set when the peripheral device terminates the channel operation by asserting the \overline{DONE} line while the peripheral device was being acknowledged. The NDT bit is cleared by writing a one to this bit or resetting the DMAC.

ERR

Error (ERR) bit is set if any errors have been signaled, When the ERR bit is set, the code corresponding to the kind of the error that occured is set in the CER. The ERR bit is clered by writing a one to this bit or resetting the DMAC.

ACT

The active (ACT) bit is asserted after the STR bit has been set and the channel operation has started. This bit remains set until the channel operation is terminated. The ACT bit is unaffected by write operations. This bit is cleared by the termination of the channel or resetting the DMAC.

DIT

Done input transition (DIT) bit is set if the \overline{DONE} input is generated while the multiple block transfer mode with \overline{DONE} is being set. The DIT bit is cleared by writing a one to this bit or resetting the DMAC.



Interrupts

The DMAC can signal the termination of the channel operation by generating an interrupt request. The interrupt request is generated by the following condition.

① INT=1

and

② COC=1 or BTC=1 or ERR=1 or NDT=1 or PCT=1 (the \overline{PCL} line is an interrupt input)

This may be represented as

IRQ=INT • (COC+BTC+ERR+NDT+PCT*)

(*PCL line is programmed as an interrupt input.)

When the \overline{IRQ} line is asserted, changing the INT bit from one to zero to one will cause the \overline{IRQ} output to change from "low" to "high" to "low" again. The \overline{IRQ} should be negated by clearing the COC, the BTC, the ERR, the NDT and the PCT bits.

If the DMAC receives \overline{IACK} from the MPU during asserting the \overline{IRQ} , the DMAC provides an interrupt vector. If multiple channels

have interrupt requests, the determination of which channel presents its interrupt vector is made using the same priority scheme defined for the channel operations.

The bus cycle in which the DMAC provides the interrupt vector when receiving an \overline{IACK} from the MPU is called the interrupt acknowledge cycle. The interrupt vector returned to the MPU comes from either the nomal or the error interrupt vector register. The normal interrupt register is used unless the ERR bit of CSR is set, in which case the error interrupt vector register is used. The content of the interrupt vector register is placed on $A_8/D_0 \sim A_{15}/D_7$, and \overline{DTACK} is asserted to indicate that the vector is on the data bus. If a reset occurs, all interrupt vector registers are set to (00001111)2, the value of the uninitialized interrupt vector of the HD68000 MPU. The timing of the interrupt acknowledge cycle is shown in Figure 36. The HD68000 MPU outputs the interrupt level into $A_1\text{-}A_3$ and "1" into $A_4\text{-}A_7$ during the interrupt acknowledge cycle, but the HD63450 DMAC ignores these signals.

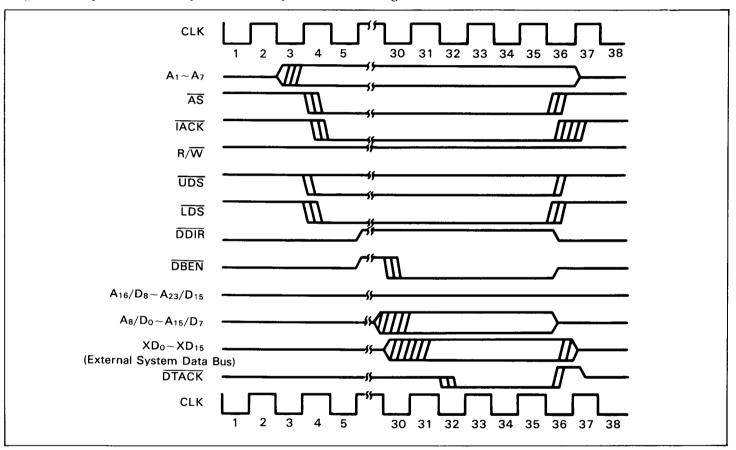


Figure 37 MPU TACK Cycle to DMAC

Multiple Data Block Transfer Operation

When the memory transfer counter (MTC) is exhausted, the channel operation still continues if the channel is set to the array chaining mode or the linked array chaining mode, and the chain is not exhausted. The channel operation also continues if the continue bit (CNT) of the CCR is set. The DMAC provides the initialization of the memory address register and the memory transfer counter in these cases so that the DMAC can transfer the multiple blocks.

Continued Operation

The continued operation is described in the Initiation and the Control of the Channel Operation section.

Array Chaining

This type of chaining uses an array in memory consisting of memory addresses and transfer counts. Each entry in the array is six bytes long and, consists of four bytes of address followed by two bytes of transfer count. The beginning address of this array is in the base address register, and the number of entries in the array is in the base transfer counter. Before starting any block transfers, the DMAC fetches the entry currently pointed to by the base address register. The address information is placed in the memory address register, and the count information is placed in the memory transfer counter. As each chaining entry is fetched, the base transfer counter is decremented by one. After the chaining entry is fetched, the base address register is incremented

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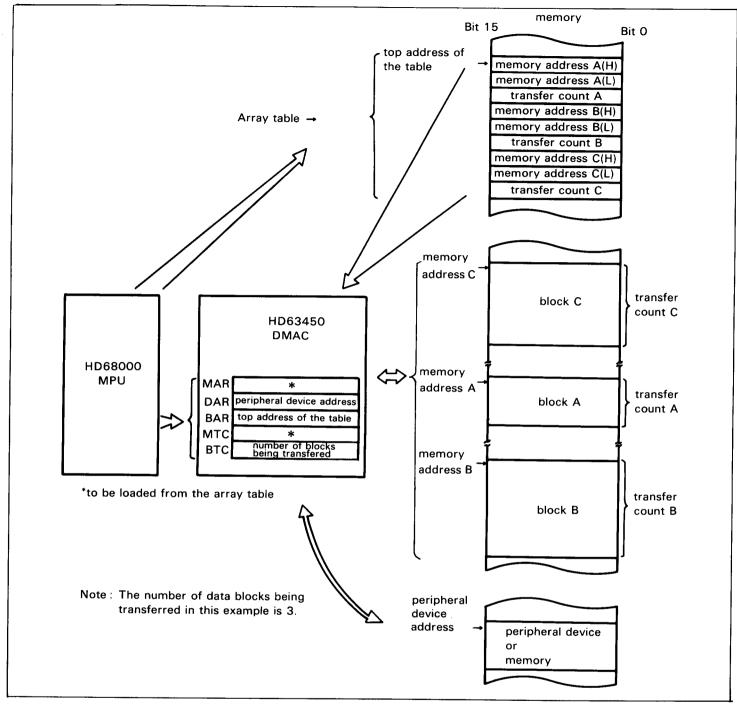


Figure 38 Transfer Example of the Array Chaining Mode

to point the next entry. When the base transfer counter reaches a terminal count of zero, the chain is exhausted, and the entry just fetched determines the last block of the channel operation.

An example of the array chaining mode operation and the memory format for supporting for array chaining is shown in Figure 38. The array must start at an even address, or the entry fetch results in an address error. If a terminal count is loaded into the memory transfer counter or the base transfer counter, the count error is signaled.

Linked Array Chaining

This type of chaining uses a list in memory consisting of memory address, transfer counts, and link addresses. Each entry in the chain list is ten bytes long, and consists of four bytes of memory address, two bytes of transfer count and four bytes of link address. The address of the first entry in the list is in the base address register, and the base transfer counter is unused. Before starting any block transfers, the DMAC fetches the entry currently pointed to by the base address register. The address information is placed in the memory address register, the count information is placed in the memory transfer counter, and the link address replaces the current contents of the base address



register. The channel then begins a new block transfer. As each chaining entry is fetched, the update base address register is examined for the terminal link which has all 32 bits equal to zero. When the new base address is the terminal address, the chain is exhausted, and the entry just fetched determines the last block of the channel operation.

An example of the linked array chaining mode operation and the memory format for supporting it is shown is Figure 39.

In Figure 39, the DMAC transfers data blocks in the order of Block A, Block B, and Block C. In the linked array chaining mode, the BTC is not used. When the DMAC refers to the linked array table, the value of the BFC is outputted as the function code. The values of the function code registers are unchanged by the linked array chaining operation.

This type of chaining allows entries to be easily removed or inserted without having to reorganize data within the chain. Since the end of the chain is indicated by a terminal link, the number of entries in the array need not be specified to the

DMAC.

The linked array table must start at an even address in the linked array chaining mode. Starting the table at an odd address results in an address error. If "0" is initially loaded to the MTC, the count error is signaled. Because the MPU can read all of the DMAC registers, all necessary error recovery information is available to the operating system.

The comparison of both chaining modes is shown in Table 8.

Table 8 Chaining Mode Address/Count Information

Chaining Mode	Base Address Register	Base Transfer Counter	Completed When Base Transfer Count=0
Array Chaining	address of the array table	number of data blocks being transferred	
Linked Array Chaining	address of the linked array table	(not used)	Linked Address=0

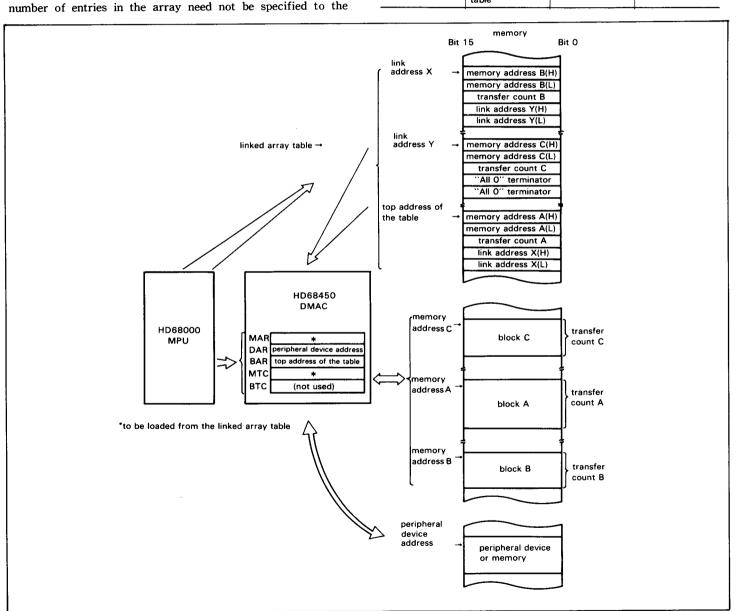


Figure 39 Transfer Example of the Linked Array Chaining Mode



Multi-Block Transfer with DONE Mode

The multi-block transfer with \overline{DONE} mode is set by setting BTD bit of the OCR. In this mode, data block transfer continues even if the \overline{DONE} signal is inputted during the DMA bus cycle. If \overline{DONE} is inputted during the DMA bus cycle when the multi-block transfer is not performed, the DMAC resets ACT bit of the CSR, sets NDT and COC bits, and terminates the DMA operation.

When DONE is inputted from the I/O device during the DMA bus cycle in which ACK is outputted, the DMAC terminates the operand transfer and then the current block transfer. Then, maintaining the bus, the DMAC sets DIT bit of the CSR and reads the data block transfer information from the memory. After that, the DMAC transfers the next block as required.

In the continue mode, if \overline{DONE} is inputted from the I/O device during the DMA bus cycle in which \overline{ACK} is outputted, the DMAC terminates the operand transfer and terminates the current block transfer. Then the DMAC shifts the data in BAR, BFC and BTC to MAR, MFC and MTC, waits for the transfer request, and transfers the next block. If the value of BAR, BFC and BTC is the same as that of MAR, MFC and MTC, the DMAC repeats transferring the same block.

As stated above, the multi-block transfer with DONE mode realizes termination (stops the current block transfer) and restart (starts transferring the next block) of the multi-block transfer in the high-speed data transfer system without MPU interposition.

Bus Exception Conditions

The DMAC has three lines for inputting bus exception conditions called $\overline{BEC_0}$, $\overline{BEC_1}$, and $\overline{BEC_2}$. The priority encoder can be used to generate these signals externally. These lines are encoded as shown in Table 9.

Table 9 BEC Bus Exception Condition

BEC ₂	BEC ₁	BEC ₀	Exception Condition
1	1	1	No exception condition
1	1	0	Halt
1	0	1	Bus error
1	0	0	Retry
0	1	1	Relinquish bus and retry
0	1	0	(undefined, reserved)
0	0	1	(undefined, reserved)
0	0	0	Reset

In order to guarantee reliable decoding, the DMAC verifies that the incoming code has been stable for two DMAC clock cycles before acting on it. The DMAC picks up $\overline{BEC_0}$ - $\overline{BEC_2}$ at the rising edge of the clock. If $\overline{BEC_0}$ - $\overline{BEC_2}$ is asserted to the undefined code, the operation of the DMAC does not proceed. For example, when the DMAC is waiting for \overline{DTACK} , inputting \overline{DTACK} does not result in the termination of the cycle if $\overline{BEC_0}$ - $\overline{BEC_2}$ is asserted to the undefined code. In addition, when the transfer request is received, \overline{BR} is not output if the $\overline{BEC_0}$ - $\overline{BEC_2}$ is not set to code (111).

If exception condition, except for HALT, is inputted during the DMA bus cycle prior to, or in coincidence with \overline{DTACK} , the DMAC terminates the current channel operation immediately. Here coincident means meeting the same set up requirements for the same sampling edge of the clock. $\overline{BEC_0} \sim \overline{BEC_2}$ is ignored in the current DMA bus cycle if it is input after \overline{DTACK} . If a bus exception condition exists, the DMAC does not generate any bus cycles until it is removed. However, the DMAC still recognizes requests.

Halt

The timing diagram of halt is shown in Figure 40. This diagram shows halt being generated during a read cycle from the 68000 compatible device in the dual addressing mode. If the halt exception is asserted during a DMA bus cycle, the DMAC does not terminate the bus cycle immediately. The DMAC waits for the assertion of \overline{DTACK} before terminating the bus cycle so that the bus cycle is completed normally. In the halted state, the DMAC puts all the control signals to high impedance and relinquishes the bus to the MPU. The DMAC does not output the \overline{BR} until halt exception is negated. When halt exception is negated, the DMAC acquires the bus again and proceeds the DMA operation. In order to insure a halt exception operation, the \overline{BEC} lines must be set to halt at least until the assertion of \overline{DTC} .

If the halt is asserted when the DMAC has the bus but is not executing any bus cycle, the DMAC relinquishes the bus as soon as halt exception is asserted.

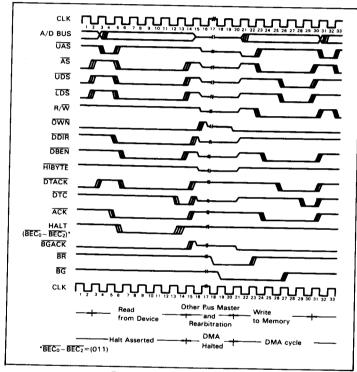


Figure 40 Halt Operation



Bus Error

The bus error exception is generated by external circuitry to indicate the current transfer cannot be successfully completed and is to be aborted. As soon as the DMAC recognizes the bus error exception, the DMAC immediately terminates the bus cycle and proceeds to the error recovery cycle. In this cycle, the DMAC adjusts the values of the MAR, the DAR, the MTC and the BTC to the values when the bus error exception occurred. 24 clocks are required for the error recovery cycle in the single addressing mode and in the read cycle of the dual addressing mode. 28 clocks are required in the write cycle of the dual addressing mode. If the DMAC does not have any transfer request in the other channels after the error recovery cycle, the DMAC relinquishes the bus.

The diagram of the bus error timing is shown in Figure 41.

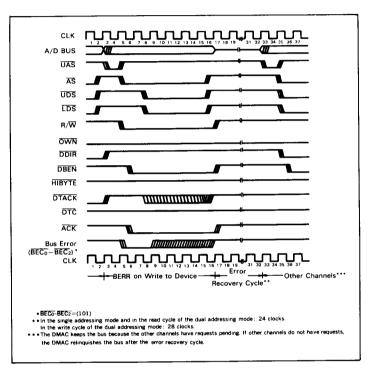


Figure 41 Bus Error Operation

Retry

The retry exception causes the DMAC to terminate the present operation and retry that operation when retry is removed, and

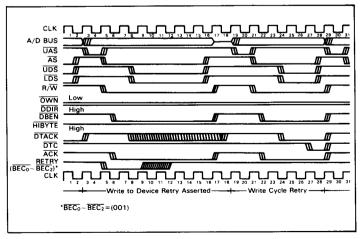


Figure 42 Retry Operation

thus will not honor any requests until it is removed. However, the DMAC still recognizes requests. The retry timing is shown in Figure 42.

Relinquish and Retry (R & R)

The relinquish and retry exception causes the DMAC to relinquish the bus and three-state all bus master controls and when the exception is removed, rearbitrate for the bus to retry the previous operation.

The diagram of the relinquish and retry timing is shown in Figure 43.

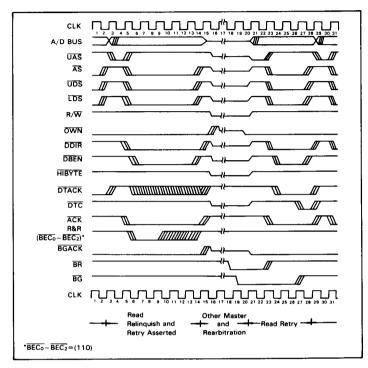


Figure 43 Relinquish and Retry Operation

Reset

The reset provides a means of resetting and initializing the DMAC. If the DMAC is bus master when the reset is asserted, the DMAC relinquishes the bus. Reset clears GCR, DCR, OCR, SCR, CCR, CSR, CPR, and CER for all channels. The NIV and the EIV are all set to (OF)₁₆, which is the uninitialized interrupt vector number for the HD68000 MPU. MTC, MAR, DAR, BTC, BAR, MFC, DFC, and BFC are not affected (see Table 10).

In order to insure a reset, $\overline{BEC_0} \sim \overline{BEC_2}$ must be kept at "Low" level for at least ten clocks.

Table 10 The Value after Resetting

Register	Value	Comments
MAR	×××××××	
DAR	×××××××	
BAR	×××××××	
MFC	×	
DFC	×	
BFC	×	
MTC	××××	
втс	××××	
NIV	0 F	uninitialized vector
EIV	0 F	uninitialized vector
CPR	0.0	
DCR	0.0	
OCR	0.0	
SCR	0 0	
CCR	0 0	
CSR	0 0 or 0 1	depending on PCL
CER	0 0	
GCR	0.0	

^{×-}indefinite value, or the value before resetting

Error Conditions

When an error is signaled on a channel, all activity on that channel is stopped. The ACT bit of the CSR is cleared, and the COC bit is set. The ERR bit of the CSR is set, and the error code is indicated in the CER. All pending operations are cleared, so that both the STR and CNT bits of CCR are cleared.

Enumerated below are the error signals and their sources.

- (a) Configuration Error—This error occurs if the STR bit is set in the following cases.
 - The CNT bit is set at the same time STR bit in the chaining mode.
 - (ii) DTYP specifies a single addressing mode, and the device port size is not the same as the operand size.
 - (iii) DTYP specifies a dual addressing mode, DPS is 16 bits, SIZE is 8 bits and REQG is "10" or "11".
 - (iv) An undefined configuration is set in the registers. The undefined configurations are: XRM=01, MAC=11, DAC=11, CHAIN=01, and SIZE=11.
 When the port size is 8 bits, SIZE=11 is not an error in the dual addressing mode.
- (b) Operation Timing Error—An operation timing error occurs in the following cases:
 - (i) When the CNT bit is set after the ACT bit has been set by the DMAC in the chaining mode, or when the STR and the ACT bits are not set.
 - (ii) The STR bit is set when ACT, COC, BTC, NDT or ERR is set.
 - (iii) An attempt to write to the DCR, OCR, SCR, MAR, DAR, MTC, MFC, or DFC is made when the STR bit or the ACT bit is set.
 - (iv) An attempt to set the CNT bit is made when the BTC and the ACT bits are set.
- (c) Address Error—An address error occurs in the following cases:

- (i) An odd address is set for word or long word operands.
- (ii) CS or IACK is asserted during the DMA bus cycle.
- (d) Bus Error—Bus error occurs when a bus error exception is signaled during a DMA bus cycle.
- (e) Count Error—A count error occurs in the following cases:
 - (i) The STR bit is set when zero is set in the MTC and the chaining mode is not used.
 - (ii) The STR bit is set when zero is set in BTC for the array chaining mode.
 - (iii) Zero is loaded from memory or the BTC to the MTC in the chaining modes or the continue mode.
- (f) External Abort—External abort occurs if an abort is asserted by the external circuitry when the PCL line is configured as an abort input and the STR or the ACT bit is set.
- (g) Software Abort—Software abort occurs if the SAB bit is set when the STR or the ACT bit is set.

Error Recovery Procedures

If an error occurs during a DMA transfer, appropriate information is available to the operating system (OS) to allow a software failure recovery operation. The operating system must be able to determine how much data was transferred, where the data was transferred to, and what type of error occurred.

The information available to the operating system consists of the present value of the Memory Address, Device Address and Base Address Register, the Memory Transfer and Base Transfer Counters, the channel status register, the channel error register. After the successful completion of any transfer, the memory and device address registers point to the location of the next operand to be transferred and the memory transfer counter contains the number of operands yet to be transferred. If an error occurs during a transfer, that transfer has not completed and the registers contain the values they had before the transfer was attempted. If the channel operation uses chaining, the Base Address Register points to the next chain entry to be serviced, unless the termination occurred while attempting to fetch an entry in the chain. In that case, the Base Address Register points to the entry being fetched. However, in the case of external abort, there are cases in which the previous values are not recovered.

Bus Exception Operating Flow

The bus exception operating flow in the case of multiple exception conditions occurring continuously in sequence is shown in Figure 44. Note that the DMAC can receive and execute the next exception condition before completing the current exception operation. For example, if the retry exception occurs, and next the relinquish and retry exception occurs while the DMAC is waiting for the retry condition to be cleared, the DMAC relinquishes the bus and waits for the exception condition to be cleared. If a bus error occurs during this period, the DMAC executes the bus error exception operation.

The flow diagram of the normal operation without exception operation or errors is shown in Figure 45.



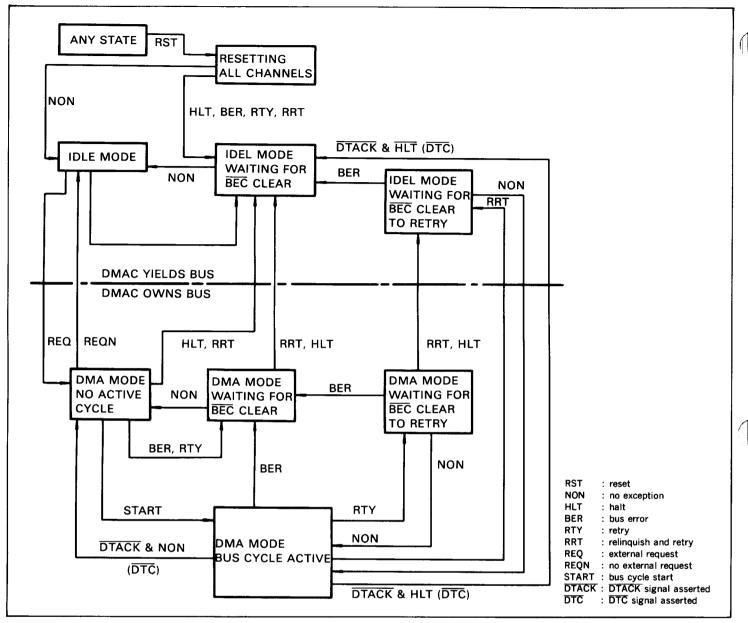


Figure 44 Bus Exception Flow Diagram

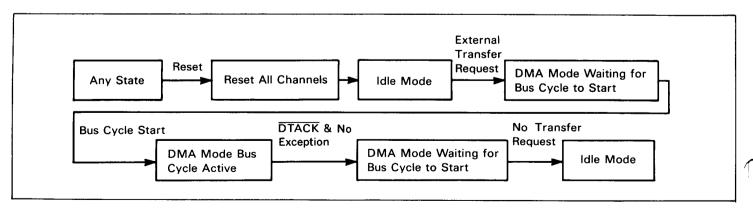


Figure 45 Flow of Normal Operation Without Exception or Error Condition



ECHANNEL PRIORITIES

Each channel has a priority level, which is determined by the contents of the Channel Priority Register (CPR). The priority of a channel is set by writing one of values (00)₂ through (11)₂, to CPR, (00)₂ being the highest priority level. When multiple requests are pending at the DMAC, the channel with the highest priority receives first service. The priority of a channel is independent of the device protocol or the request mechanism for

that channel. If there are several requesting channels at the same priority level, a round-robin resolution is used, that is the DMAC does operand transfers in rotation starting form the channel of the lowest address.

Resetting the DMAC sets the priority level of all channels to "(00)₂", the highest priority level.

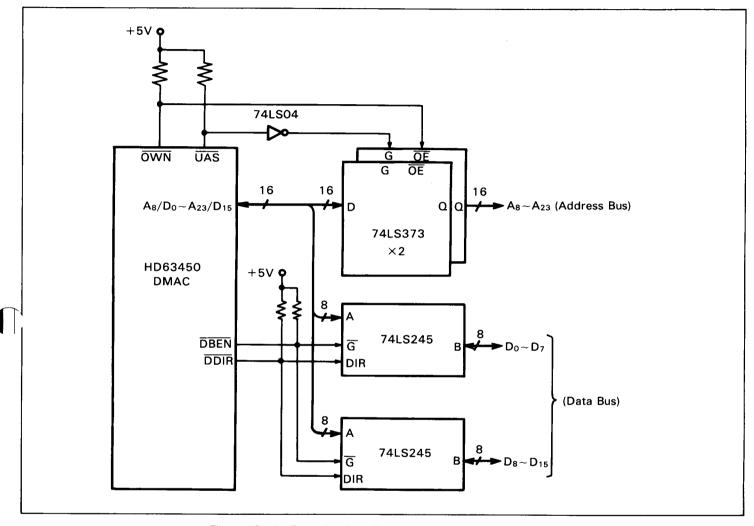


Figure 46 An Example of the Demultiplexed Address Data Bus

APPLICATIONS

Examples of how to interface HD63450 to an HD68000 based system are shown in Figures 46 and 47.

Figure 46 shows an example of how to demultiplex the address/data bus. \overline{OWN} and \overline{UAS} are used to control 74LS373 for latching the address. \overline{DBEN} and \overline{DDIR} are used to control the bi-

directional buffer 74LS245. These signals are three-stated at active low, which requires pull-up resistors.

Figure 47 shows an example of inter-device connection in the HD68000 system. REQ, ACK, PCL, DTC, and DONE are used to control I/O devices.



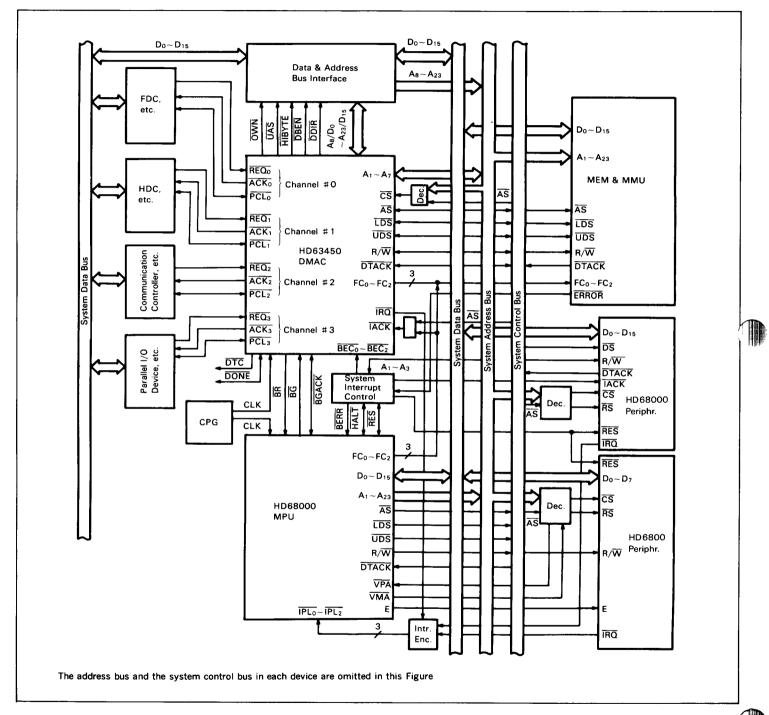


Figure 47 An Example of Inter-Device Connection in the HD68000 System

■ NOTES FOR USING HD63450

(1) I/O device connection in HD6800 mode.

When the DMAC is reading data from the HD6800 type peripheral device, the data is to be latched not at the falling edge of E clock but at that of CLK of \overline{DTC} assertion. As shown in the figure below, the 74LS373 is externally required to keep this data on the bus of the DMAC.

(2) External abort during the DONE input cycle

In case of I/O device-to-Memory transfer under the dual addressing mode, the \overline{DONE} input occurs during the read cycle of I/O device-to-DMAC registers.

The external abort (\overline{PCL}) is configured as an external abort input.) will be ignored during the write cycle which subsequently starts after the DMAC enters the \overline{DONE} input cycle.

In this case, the registers CSR and CER indicate the normal transfer termination informed by the \overline{DONE} input. When PCT = "1", ERR = "0", and NDT = "1" are set in CSR, an external abort has occurred.

(3) Multiple errors in one channel

In case of the sequential multiple errors in one channel, the DMAC indicates only the first one. The error code once set in CER is reserved until the ERR bit is reset.

(4) Attention for mounting the DMAC

The thick wiring is recommended to be used to connect the V_{ss} pin of the DMAC to the ground of the circuit board.

When using a socket, note that the V_{SS} pin should make a good contact with the socket.

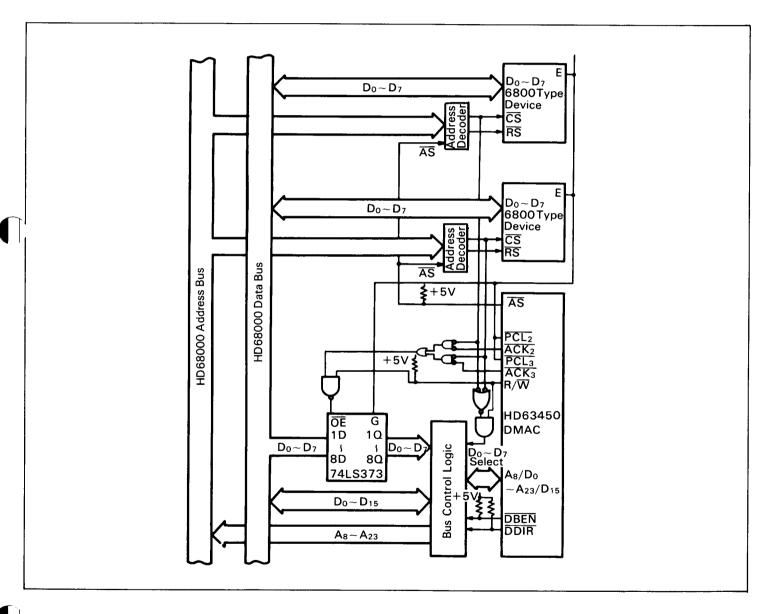
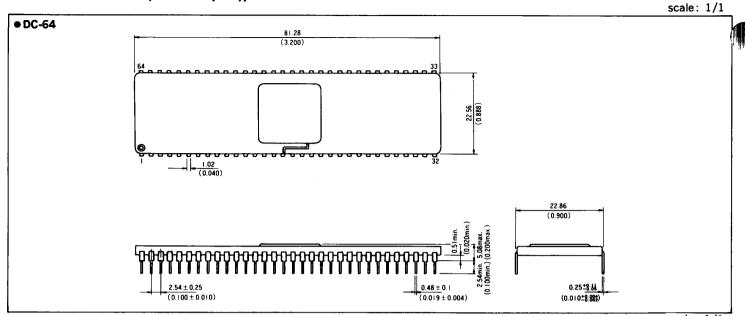
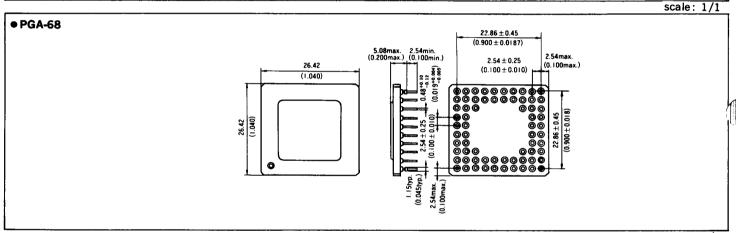


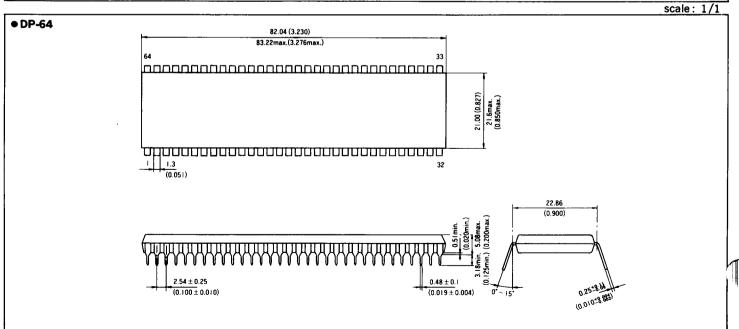
Figure 48 An Example of Connection with HD6800 type Peripheral Devices (channel 2 and 3 are used)



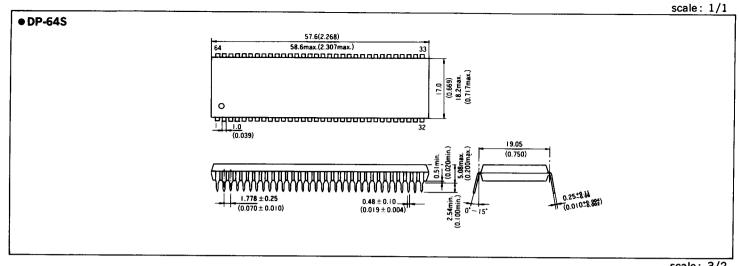
■ PACKGE DIMENSIONS (Unit: mm (inch))

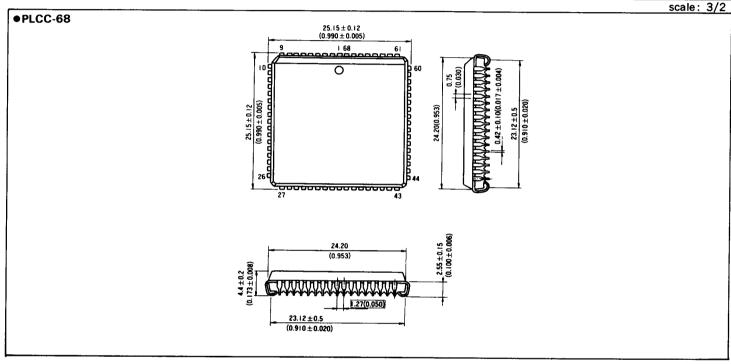






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